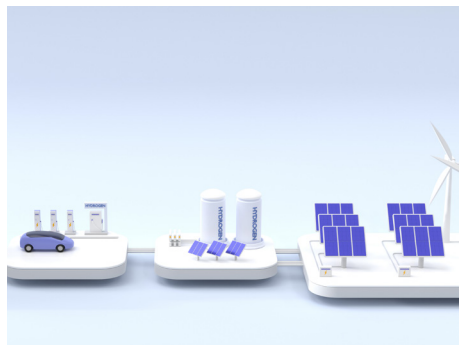


High-Voltage Power Discretes and Modules



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mSiC™ MOSFETs



Silicon Carbide (SiC) is the ideal technology for higher switching frequency, higher efficiency, and higher power (>650V) applications. The following are the target markets and applications:

- Transportation/automotive: Electric Vehicle (EV) battery charger, Hybrid Electric Vehicle (HEV) powertrain, DC-DC converter, energy recovery
- Data center: Uninterruptible Power Supply (UPS), Power Distribution Unit (PDU), and PSU (PFC/LLC) power supplies
- Commercial aviation: actuation, air conditioning and power distribution
- Industrial: induction heating, motor drives, Switched Mode Power Supply (SMPS), welding
- Smart energy: energy storage, PhotoVoltaic (PV) inverter, wind turbine
- Medical: MRI power supply, X-ray power supply
- Defense: motor drives, power supplies

mSiC MOSFET and mSiC Diode (Schottky Barrier Diode) product lines from Microchip increase your system efficiency over silicon MOSFET and IGBT solutions while lowering your cost of ownership by enabling downsized systems and smaller/lower-cost cooling.

Discrete mSiC™ MOSFETs

Characteristics	Results	Benefits
Breakdown field (MV/cm)	Lower on-resistance	Higher efficiency
Electron sat. velocity (cm/s)	Faster switching	Size reduction
Bandgap energy (ev)	Higher junction temperature	Improved cooling
Thermal conductivity (W/m.K)	Higher power density	Higher current capabilities
Positive temperature coefficient	Self regulation	Easy paralleling

Advantages Versus Competition: Quality, Supply and Support (QSS)

Quality

- $R_{DS(on)}$ stability over temperature
- High avalanche performance – UIS and repetitive UIS
- Long short circuit withstand time
- No lifetime degradation of the internal body diode

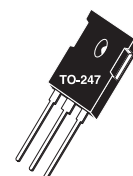
Supply

- Multiple qualified sources of substrate and epitaxy material
- Dual fabrication capability
- No End of Life (EOL) practice
- Competitive lead times

Support

- Broad power switching portfolio – Discretes, die, and modules
- Microchip's complete power system portfolio including - Power stage, gate driver and control solutions
- Expertise and support infrastructure in Aerospace, Defense, Industrial and Automotive

Part Number	Voltage (V)	R _{DS(on)} (mΩ)	Package Style
MSC090SMA070SA	700	90	TO-263-7
MSC090SMA070SC			PSMT
MSC090SMA070B			TO-247
MSC090SMA070S			TO-268
MSC090SMA070SD 			TO-263-7 XL
MSC060SMA070B		60	TO-247
MSC060SMA070B4			TO-247-4L
MSC060SMA070S			TO-268
MSC060SMA070SD 			TO-263-7 XL
MSC060SMA070SC			PSMT
MSC035SMA070B 		35	TO-247
MSC035SMA070B4			TO-247-4L
MSC035SMA070S			TO-268
MSC035SMA070B4N 			TO-247-4L Notch
MSC015SMA070B		15	TO-247
MSC015SMA070B4			TO-247-4L
MSC015SMA070S			TO-268
MSC015SMA070B4N 			TO-247-4L Notch
MSC360SMA120SA	1200	360	TO-263-7
MSC360SMA120B			TO-247
MSC360SMA120S			TO-268
MSC360SMA120SD 			TO-263-7 XL
MSC360SMA120SC			PSMT
MSC180SMA120SA		180	TO-263-7
MSC180SMA120B			TO-247
MSC180SMA120S			TO-268
MSC180SMA120SD 			TO-263-7 XL
MSC180SMA120SC			PSMT
MSC080SMA120B		80	TO-247
MSC080SMA120B4			TO-247-4L
MSC080SMA120S			TO-268
MSC080SMA120J			SOT-227
MSC080SMA120SD 			TO-263-7 XL
MSC080SMA120SC		40	PSMT
MSC040SMA120B			TO-247
MSC040SMA120B4			TO-247-4L
MSC040SMA120S			TO-268
MSC040SMA120J			SOT-227
MSC040SMA120B4N 		25	TO-247-4L Notch
MSC025SMA120B			TO-247
MSC025SMA120B4			TO-247-4L
MSC025SMA120S			TO-268
MSC025SMA120J			SOT-227
MSC025SMA120B4N 		17	TO-247-4L Notch
MSC017SMA120B			TO-247
MSC017SMA120B4			TO-247-4L
MSC017SMA120J			SOT-227
MSC017SMA120S			TO-268
MSC017SMA120B4N 			TO-247-4L Notch
MSC750SMA170SA	1700	750	TO-263-7
MSC750SMA170B			TO-247
MSC750SMA170B4			TO-247-4L
MSC750SMA170S			TO-268
MSC035SMA170B		35	TO-247
MSC035SMA170B4			TO-247-4L
MSC035SMA170S			TO-268
MSC400SMA330B4	3300	400	TO-247-4L
MSC080SMA330B4		80	TO-247-4L
MSC025SMA330B4		25	TO-247-4L



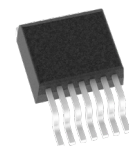
TO-247[B]



TO-247-4L[B4]



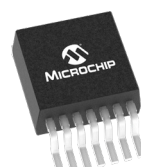
TO-247-4L Notch [B4N]



TO-263-7 (D2PAK-7) [SA]



PSMT [SC]



TO-263-7 XL (D2PAK-7 XL) [SD]



TO-268 (D3PAK) [S]



SOT-227 (Isolated Base) [J]



Power MOS 8™ MOSFETs/FREDFETs

Power MOS 8 is Microchip's latest family of high-speed, high-voltage (500-1200V) N-channel switch-mode power transistors with lower EMI characteristics and lower cost compared to previous generation devices. These new MOSFETs/FREDFETs have been optimized for both hard and soft switching in high-frequency, high-voltage applications rated above 500W. There are 2 product types in the Power MOS 8 MOSFET family:

1) MOSFET

2) FREDFETs have a fast recovery body diode characteristic, providing high commutation dv/dt ruggedness and high reliability in ZVS circuits.

Features

- Fast switching
- Low EMI
- Quiet switching
- Avalanche-energy rated
- Low gate charge

Applications

- Power factor correction
- Server and telecom power systems
- Solar inverters
- Semiconductor capital equipment
- Induction heating
- Arc welding
- Plasma cutting
- Battery chargers
- Medical

The new Power MOS 8 series is a result of extensive research into quiet switching. Input and reverse transfer capacitance values as well as their ratio were set at specific values to achieve quiet switching with minimal switching loss. The Power MOS 8 series of devices are inherently quiet switching, stable when connected in parallel and very efficient.

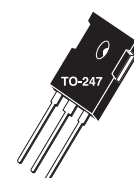
Body Diode Options

As with previous generation products, Power MOS 8 MOSFETs and FREDFETs are available in all voltage ratings. A FREDFET is a MOSFET with a faster recovery intrinsic body diode. This results in improved reliability in ZVS circuits due to shorter minority carrier lifetime and increased commutation dv/dt ruggedness. If a fast recovery body diode is not needed, MOSFET versions are available.

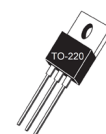
Power MOS 8™ MOSFETs/FREDFETs

$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω) Max	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
1200	4.20			4	APT4F120K	TO-220
	4.20			4	APT4F120S	D3PAK
	3.80	5	APT4M120K			TO-220
	2.40			7	APT7F120B	TO-247 or D3PAK
	2.10	8	APT7M120B			TO-247
	1.20			14	APT13F120B	TO-247 or D3PAK
	1.10	14	APT14M120B			TO-247 or D3PAK
	0.70			23	APT22F120B2	T-MAX® or TO-264
	0.63	24	APT24M120B2			T-MAX or TO-264
	0.58			27	APT26F120B2	T-MAX or TO-264
	0.58			18	APT17F120J	SOT-227
	0.53	29	APT28M120B2			T-MAX or TO-264
	0.53	19	APT19M120J			SOT-227
	0.32			33	APT32F120J	SOT-227
	0.29	35	APT34M120J			SOT-227
1000	2.00			7	APT7F100B	TO-247
	1.80	8	APT8M100B			TO-247
	1.60			9	APT9F100B	TO-247
	1.40	9	APT9M100B			TO-247 or D3PAK
	0.98			14	APT14F100B	TO-247 or D3PAK
	0.88	14	APT14M100B			TO-247 or D3PAK
	0.78			17	APT17F100B	TO-247 or D3PAK
	0.70	18	APT18M100B			TO-247 or D3PAK
	0.44			30	APT29F100B2	T-MAX or TO-264
	0.44			20	APT19F100J	SOT-227
	0.38	32	APT31M100B2	35		T-MAX or TO-264
	0.38	21	APT21M100J	23		SOT-227
	0.38			35	APT34F100B2	T-MAX or TO-264
	0.38			23	APT22F100J	SOT-227
	0.33	37	APT37M100B2			T-MAX or TO-264
	0.33	25	APT25M100J			SOT-227
	0.20			42	APT41F100J	SOT-227
	0.18	45	APT45M100J			SOT-227
800	0.90			12	APT11F80B	TO-247
	0.80	13	APT12M80B			TO-247
	0.58			18	APT17F80B	TO-247 or D3PAK
	0.53	19	APT18M80B			TO-247
	0.43			23	APT22F80B	TO-247 or D3PAK
	0.39	25	APT24M80B			TO-247 or D3PAK
	0.24			41	APT38F80B2	T-MAX or TO-264
	0.21	43	APT41M80B2			T-MAX or TO-264
	0.21			47	APT44F80B2	T-MAX or TO-264
	0.21			31	APT29F80J	SOT-227
	0.19	49	APT48M80B2			T-MAX or TO-264
	0.19	33	APT32M80J			SOT-227
	0.11			57	APT53F80J	SOT-227
	0.10	60	APT58M80J			SOT-227

Part numbers for D3PAK packages—replace “B” with “S” in part number.
Part numbers for TO-264 packages—replace “B2” with “L” in part number.



TO-247[B]



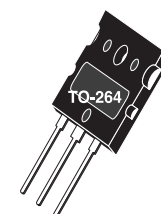
TO-220[K]



TO-268 (D3PAK) [S]



T-MAX®[B2]



TO-264[L]

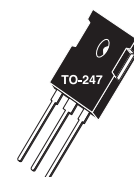


SOT-227[J]
(Isolated Base)

Power MOS 8 MOSFETs/FREDFETs (Continued)

$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω) Max	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
600	0.37			19	APT18F60B	TO-247
	0.29			24	APT23F60B	TO-247
	0.19	36	APT34M60B	36	APT34F60B	TO-247 or D3PAK
	0.15	45	APT43M60B2	45	APT43F60B2	T-MAX® or TO-264
	0.15	31	APT30M60J	31	APT30F60J	SOT-227
	0.11	60	APT56M60B2	60	APT56F60B2	T-MAX or TO-264
	0.11	42	APT39M60J	42	APT39F60J	SOT-227
	0.09	70	APT66M60B2	70	APT66F60B2	T-MAX or TO-264
	0.09	49	APT47M60J	49	APT47F60J	SOT-227
	0.055	84	APT80M60J	84	APT80F60J	SOT-227
500	0.24			24	APT24F50B	TO-247
	0.19			30	APT30F50B	TO-247 or D3PAK
	0.15			37	APT37F50B	TO-247 or D3PAK
	0.13			43	APT42F50B	TO-247 or D3PAK
	0.10	56	APT56M50B2	56	APT56F50B2	T-MAX or TO-264
	0.10	38	APT38M50J	38	APT38F50J	SOT-227
	0.075	75	APT75M50B2	75	APT75F50B2	T-MAX or TO-264
	0.075	51	APT51M50J	51	APT51F50J	SOT-227
	0.065	84	APT84M50B2	84	APT84F50B2	T-MAX or TO-264
	0.065	58	APT58M50J	58	APT58F50J	SOT-227
	0.036	103	APT100M50J	103	APT100F50J	SOT-227

Part numbers for D3PAK packages—replace “B” with “S” in part number.
Part numbers for TO-264 packages—replace “B2” with “L” in part number.



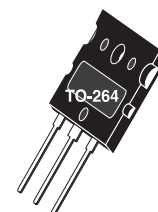
TO-247[B]



TO-268 (D3PAK) [S]



T-MAX® [B2]



TO-264[L]

Low-Voltage Power MOS V[®] MOSFETs/FREDFETs

$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω) Max	I_D (A)	MOSFET Part Number	I_D (A)	FREDFET Part Number	Package Style
300	0.085	40	APT30M85BVRG			TO-247
	0.070	48	APT30M70BVRG	48	APT30M70BVFRG	TO-247
	0.040	70	APT30M40JVR	70	APT30M40JVFR	SOT-227
	0.019	130	APT30M19JVR	130	APT30M19JVFR	SOT-227
200	0.045	56	APT20M45BVRG	56	APT20M45BVFRG	TO-247 or D3PAK
	0.038	67	APT20M38BVRG			TO-247 or D3PAK
			APT20M22LVRG			SOT-227
	0.022		APT20M22JVR	100	APT20M22LVFRG	TO-264
	0.018	100	APT20M18B2VRG	100	APT20M18B2VFRG	T-MAX® or TO-264
	0.011	175	APT20M11JVR	175	APT20M11JVFR	SOT-227

Part numbers for D3PAK packages—replace “B” with “S” in part number.
Part numbers for TO-264 packages—replace “B2” with “L” in part number.



SOT-227[J]
(Isolated Base)

Ultra-Fast, Low Gate Charge MOSFETs



For 250 kHz–2 MHz Switching Applications

The ultra-fast, low gate charge MOSFET family combines the lowest gate charge available in the industry with Microchip's proprietary self-aligned aluminum metal gate structure. The result is a MOSFET capable of extremely fast switching speeds and very low switching losses. The metal gate structure and the layout of these chips provide an internal Series Gate Resistance (EGR) an order of magnitude lower than competitive devices built with a polysilicon gate.

These devices are ideally suited for high-frequency and pulsed high-voltage applications.

Typical Applications

- Class D amplifiers up to 2 MHz
- High-voltage pulsed DC
- AM transmitters
- Plasma deposition/etch

Features

- Series gate resistance (R_{GS}) $< 0.1 \Omega$
- T_R and T_F times of < 10 ns
- Industry's lowest gate charge

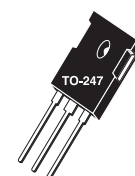
Benefits

- Fast switching, uniform signal propagation
- Pulse power applications
- Fast switching, reduced gate drive power

Ultra-Fast, Low Gate Charge MOSFETs

$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω) Max	I_D (A)	MOSFET Part Number	FREDFET Part Number	Package Style
1200	4.700	3.5		APT1204R7BFLLG	TO-247 or D3PAK
	1.400	9		APT1201R4BFLLG	TO-247
	0.570	22	APT12057B2LLG		T-MAX®
1000	0.900	12	APT10090BLLG		TO-247
	0.780	14	APT10078BLLG		TO-247 or D3PAK
	0.450	23	APT10045B2LLG		T-MAX or TO-264
	0.450	21	APT10045JLL		SOT-227
	0.370	25		APT10035JFLL	SOT-227
	0.370	28		APT10035B2FLLG	T-MAX
	0.350	28	APT10035LLG		TO-264
	0.350	25	APT10035JLL		SOT-227
	0.260	38		APT10026L2FLLG	264-MAX™
	0.260	30	APT10026JLL	APT10026JFLL	SOT-227
	0.210	37	APT10021JLL	APT10021JFLL	SOT-227
800	0.260	29		APT8024JFLL	SOT-227
	0.240	29	APT8024JLL		SOT-227
	0.200	38	APT8020B2LLG	APT8020B2FLLG	T-MAX or TO-264
	0.200	33	APT8020JLL		SOT-227
	0.160	42		APT8014JFLL	SOT-227
	0.140	52	APT8014L2LLG	APT8014L2FLLG	264-MAX
	0.140	42	APT8014JLL		SOT-227
	0.110	51	APT8011JLL	APT8011JFLL	T-MAX or TO-264
500	0.140	35	APT5014BLLG		TO-247
	0.100	46	APT5010B2LLG	APT5010B2FLLG	T-MAX or TO-264
	0.075	51	APT50M75JLL	APT50M75JFLL	SOT-227
	0.075	57	APT50M75B2LLG		T-MAX or TO-264
	0.065	67	APT50M65LLG	APT50M65B2FLLG	TO-264
	0.065	58	APT50M65JLL	APT50M65JFLL	SOT-227
	0.050	71	APT50M50JLL	APT50M50JFLL	SOT-227
	0.038	88	APT50M38JLL	APT50M38JFLL	SOT-227

Part numbers for D3PAK packages—replace “B” with “S” in part number.
Part numbers for TO-264 packages—replace “B2” with “L” in part number.



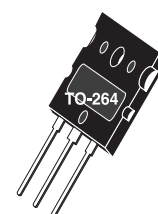
TO-247[B]



T-MAX®[B2]



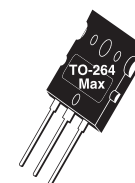
SOT-227[J]
(Isolated Base)



TO-264[L]



TO-268 (D3PAK) [S]



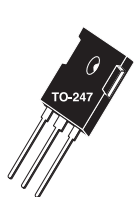
264-MAX™[L2]



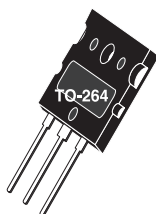
Superjunction MOSFETs

$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω) Max	$I_{D(CONT)}$ (A)	Part Number	Package Style
800	C3 Technology			
	0.450	11	APT11N80BC3G	TO-247
	0.145	34	APT34N80B2C3G	T-MAX® or TO-264
600	0.070	47	APT47N60BC3G	TO-247 or D3PAK
	0.035	77	APT77N60JC3	SOT-227
	0.042	94	APT94N60L2C3G	264-MAX™
600	Server Series			
	0.045	60	APT60N60BCSG	TO-247 or D3PAK
	C6 Technology			
	0.041	77	APT77N60BC6	TO-247 or D3PAK
	0.070	53	APT53N60BC6	TO-247
	0.099	38	APT38N60BC6	TO-247 or D3PAK
	0.125	30	APT30N60BC6	TO-247 or D3PAK
	0.035	106	APT106N60B2C6	T-MAX or TO-264

Part numbers for D3PAK packages—replace “B” with “S” in part number.
Part numbers for TO-264 packages—replace “B2” with “L” in part number.



TO-247[B]



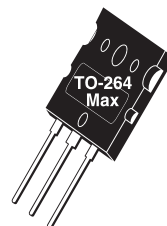
TO-264[L]



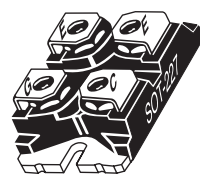
TO-268 (D3PAK) [S]



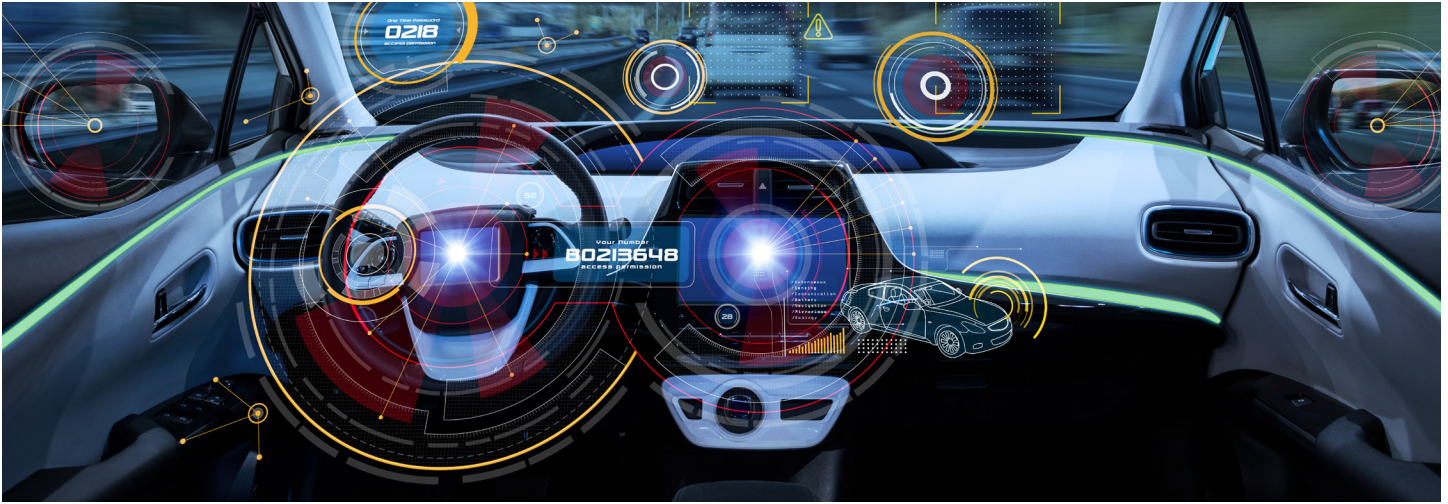
T-MAX®[B2]



264-MAX™[L2]



SOT-227[J]
(Isolated Base)



Linear MOSFETs

What is a Linear MOSFET?

A MOSFET specifically designed to be more robust than a standard MOSFET when operated with both high voltage and high current near DC conditions (>100 ms).

The Problem with SMPS MOSFETs

MOSFETs optimized for high-frequency SMPS applications have poor high voltage DC SOA. Most SMPS-type MOSFETs overstate SOA capability at high voltage on the datasheets. Above ~30V and DC conditions, SOA drops faster than is indicated by Power Dissipation (PD) limited operation. For pulsed loads ($t < 10$ ms), there is generally no problem using a standard MOSFET.

Technology Innovation

Introduced in 1999, Microchip modified its proprietary patented self-aligned metal gate MOSFET technology for enhanced performance in high voltage, linear applications. These linear MOSFETs typically provide 1.5–2.0 times the DC SOA capability at high voltage compared to other MOSFET technologies optimized for switching applications.

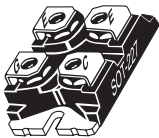
$V_{BR(DSS)}$ (V)	$R_{DS(on)}$ (Ω)	$I_{D(CONT)}$ (A)	SOA (W)	Part Number
1000	0.60	18	325	APL1001J
600	0.125	49	325	APL602B2G
	0.125	43	325	APL602J
500	0.12	43	325	APL501J
	0.090	58	325	APL502B2G
	0.090	52	325	APL502J
Part numbers for TO-264 packages—replace “B2” with “L” in part number.				

A Design Will Need Linear MOSFETs in the Following Situations

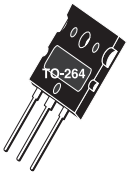
- High current and less than 200 volts at less than 100 milliseconds
- Used as a variable power resistor
- Soft start application (limit surge currents)
- Linear amplifier circuit

Typical Applications

- Active loads above 200 volts, such as DC dynamic loads for testing power supplies, batteries, fuel cells, etc.
- High voltage, high current, constant current sources



SOT-227[J]
(Isolated Base)



TO-264[L]



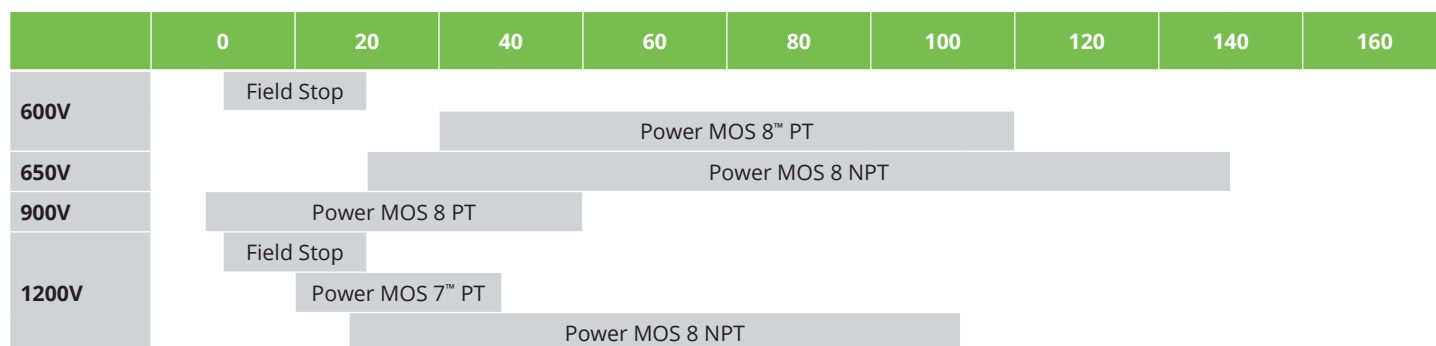
T-MAX® [B2]



IGBTs

IGBT products from Microchip provide high-quality solutions for a wide range of high-voltage and high-power applications. The switching frequency range spans from DC for minimal conduction loss to 150 kHz for very-high-power-density Switch Mode Power Supply (SMPS) applications. The frequency range for each product type is shown in the following graph. Each IGBT product represents the latest in IGBT technology, providing the best possible performance/cost combination for the targeted application. There are six product series that utilize three different IGBT technologies: Non-Punch-Through (NPT), Punch-Through (PT) and field stop.

IGBT Switching Frequency Ranges (kHz, Hard Switched)



Note: Frequency ranges shown are typical for a 50 A IGBT. Refer to product datasheet maximum frequency versus current graph for more information.

Standard Series	Voltage Ratings (V)	Technology	Easy to Parallel	Short Circuit Safe Operating Area (SOA)	Parameter
MOS 7	600, 900, 1200	PT			Ultra-low gate charge
MOS 8	600, 650, 900, 1200	PT, NPT			Highest efficiency
Field Stop Trench Gate	600, 1200	Field Stop	•	•	Lowest conduction loss

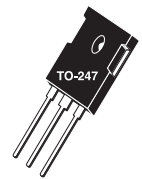
Product Options

All standard IGBT products are available as a single IGBT or as a co-packaged product with an anti-parallel DQ series diode. Package options include TO-220, TO-247, T-MAX®, TO-264 and SOT-227. Customized products are available; contact the factory for details.

IGBTs—Punch-Through

	V _{(BR)CES} (V)	V _{CE(ON)} (V) Typ 25°C	I _{C2} (A) 100°C	Maximum I _C (A) at Frequency		Part Number	Package Style
POWER MOS 7™	Single			100 kHz	200 kHz		
 - Ultra-low gate charge - Co-packaged with high-speed DQ diode	600	2.2	27	19	12	APT15GP60BG	TO-247
		2.2	49	37	24	APT30GP60BG	TO-247
		2.2	62	41	26	APT40GP60BG	TO-247
		2.2	40	25	16	APT40GP60J	SOT-227
		2.2	72	41	26	APT50GP60BG	TO-247
		2.2	46	26	19	APT50GP60J	SOT-227
		2.2	100	72	45	APT80GP60B2G	T-MAX®
				50 kHz	100 kHz		
		2.2	96	76	54	APT65GP60B2G	T-MAX
		2.2	60	47	33	APT65GP60J	SOT-227
		2.2	68	59	39	APT80GP60J	SOT-227
	900	3.2	36	33	21	APT25GP90BG	TO-247
		3.2	50	N/A	N/A	APT40GP90BG	TO-247
		3.2	32	N/A	N/A	APT40GP90J	SOT-227
				20 kHz	40 kHz		
	1200	3.3	33	19	12	APT25GP120BG	TO-247
		3.3	46	24	15	APT35GP120BG	TO-247
		3.3	54	29	18	APT45GP120BG	TO-247
		3.3	34	28	18	APT45GP120J	SOT-227
		3.3	91	42	24	APT75GP120B2G	T-MAX
		3.3	57	40	23	APT75GP120J	SOT-227
	Co-packaged (IGBT & "DQ" FRED)			50 kHz	100 kHz		
		2.2	60	47	33	APT65GP60J/DQ2	SOT-227
		2.2	96	76	54	APT65GP60L2DQ2G	264-MAX®
		2.2	68	59	39	APT80GP60J/DQ3	SOT-227
				100 kHz	200 kHz		
		2.2	27	19	12	APT15GP60BDQ1G	TO-247
		2.2	49	37	24	APT30GP60BDQ1G	TO-247
		2.2	62	41	26	APT40GP60B2DQ2G	TO-247
		2.2	40	25	16	APT40GP60J/DQ2	SOT-227
		2.2	72	N/A	N/A	APT50GP60B2DQ2G	TO-247
		2.2	46	N/A	N/A	APT50GP60J/DQ2	SOT-227
				20 kHz	40 kHz		
		3.2	21	27	20	APT15GP90BDQ1G	TO-247
		3.2	36	53	34	APT25GP90BDQ1G	TO-247
		3.2	50	56	40	APT40GP90B2DQ2G	T-MAX
		3.2	27	33	24	APT40GP90J/DQ2	SOT-227
				50 kHz	100 kHz		
		3.3	20	17	11	APT13GP120BDQ1G	TO-247
		3.3	33	19	12	APT25GP120BDQ1G	TO-247
		3.3	46	24	15	APT35GP120B2DQ2G	T-MAX
		3.3	54	29	18	APT45GP120B2DQ2G	T-MAX
		3.3	34	30	16	APT45GP120J/DQ2	SOT-227
		3.3	57	44	23	APT75GP120J/DQ3	SOT-227
POWER MOS 8™	Single			50 kHz	80 kHz		
 - Fast switching - Highest efficiency - Co-packaged with high-speed DQ diode	600	2	36	21	17	APT36GA60B	TO-247
		2	44	26	20	APT44GA60B	TO-247
		2	54	30	23	APT54GA60B	TO-247
		2	68	35	27	APT68GA60B	TO-247
		2	80	40	31	APT80GA60B	TO-247
		2	102	51	39	APT102GA60B2	T-MAX or TO-264
				25 kHz	50 kHz		
	900	2.5	35	17	10	APT35GA90B	TO-247
		2.5	43	21	13	APT43GA90B	TO-247
		2.5	64	29	19	APT64GA90B	TO-247
		2.5	80	34	23	APT80GA90B	TO-247
	Co-packaged (IGBT & "DQ" FRED)			50 kHz	80 kHz		
		2	36	21	17	APT36GA60BD15	TO-247
		2	44	26	20	APT44GA60BD30	TO-247
		2	47	N/A	N/A	APT47GA60J/D40	SOT-227
		2	54	30	23	APT54GA60BD30	TO-247
		2	60	48	36	APT60GA60J/D60	SOT-227
		2	68	35	27	APT68GA60B2D40	T-MAX or TO-264
		2	80	40	31	APT80GA60LD40	TO-264
				25 kHz	50 kHz		
		2.5	27	14	8	APT27GA90BD15	TO-247
		2.5	35	17	10	APT35GA90BD15	TO-247
		2.5	43	21	13	APT43GA90BD30	TO-247
		2.5	46	33	21	APT46GA90J/D40	SOT-227
		2.5	64	29	19	APT64GA90B2D30	T-MAX or TO-264
		2.5	80	34	23	APT80GA90LD40	TO-264

Part numbers for D3PAK packages—replace "B" with "S" in part number.
Part numbers for TO-264 packages—replace "B2" with "L" in part number.



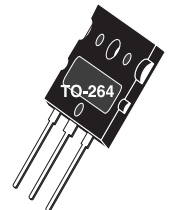
TO-247[B]



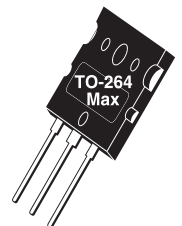
TO-268 (D3PAK) [S]



T-MAX®[B2]



TO-264[L]



264-MAX™[L2]

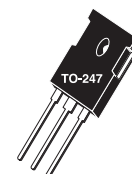


SOT-227[J]

IGBTs—Non-Punch-Through

POWER MOS 8™

	$V_{(BR)CES}$ (V)	$V_{CE(ON)}$ (V) Typ 25°C	I_{c2} (A) 100°C	Maximum I_c (A) at Frequency		Part Number	Package Style
	Single			100 kHz	200 kHz		
		1.9	45	45	25	APT45GR65B	TO-247
				100 kHz	150 kHz		
	650	1.9	70	52	39	APT70GR65B	TO-247
				50 kHz	100 kHz		
		1.9	95	75	42	APT95GR65B2	T-MAX®
				100 kHz	150 kHz		
		2.5	25	25	21	APT25GR120B	TO-247
				50 kHz	80 kHz		
		2.5	40	38	28	APT40GR120B	TO-247
				25 kHz	50 kHz		
		2.5	70	66	53	APT70GR120B2	T-MAX
				50 kHz	80 kHz		
		2.5	40	38	28	APT40GR120S	D3PAK
				25 kHz	50 kHz		
		2.5	70	66	53	APT70GR120L	TO-264
				50 kHz	80 kHz		
		2.5	85	80	46	APT85GR120B2	T-MAX
				25 kHz	50 kHz		
		2.5	85	80	46	APT85GR120L	TO-264
				50 kHz	80 kHz		
		2.5	85	75	50	APT85GR120J	SOT-227
				50 kHz	80 kHz		
		2.5	40	38	28	APT40GR120B2D30	T-MAX
				25 kHz	50 kHz		
		2.5	50	45	32	APT50GR120JD30	SOT-227
				50 kHz	80 kHz		
		2.5	70	50	30	APT70GR120JD60	SOT-227
				50 kHz	80 kHz		
		2.5	85	75	50	APT85GR120JD60	SOT-227



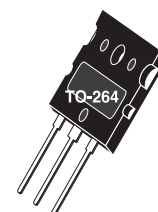
TO-247[B]



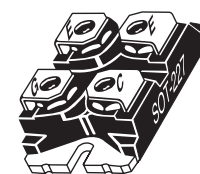
TO-268 (D3PAK) [S]



T-MAX®[B2]



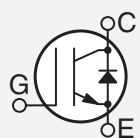
TO-264[L]



SOT-227[J]

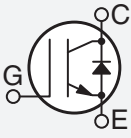


- High-speed switching
- Low switching losses
- Easy to parallel



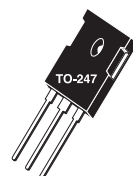
Current at frequency test conditions: $T_j = 125^\circ\text{C}$, $T_c = 100^\circ\text{C}$ except SOT-227 where $T_c = 80^\circ\text{C}$, $V_{cc} = 67\%$ rated voltage hard switch.

IGBTs—Field Stop

	V _{(BR)CES} (V)	V _{CE(ON)} (V) Typ 25°C	I _{C2} (A) 100°C	Maximum I _C (A) at Frequency		Part Number	Package Style
Field Stop	Single			15 kHz	30 kHz		
 - Trench technology - Short circuit rated - Lowest conduction loss - Easy paralleling - Co-packaged with high-speed DQ diode 	600	1.5	24	15	10	APT20GN60BG	TO-247
		1.5	37	20	14	APT30GN60BG	TO-247
		1.5	64	30	21	APT50GN60BG	TO-247
		1.5	93	42	30	APT75GN60BG	TO-247
		1.5	123	75	47	APT150GN60J	SOT-227
		1.5	135	54	39	APT100GN60B2G	T-MAX®
		1.5	190	79	57	APT150GN60B2G	T-MAX
		1.5	230	103	75	APT200GN60B2G	T-MAX
		1.5	158	100	66	APT200GN60J	SOT-227
	1200			10 kHz	20 kHz		
		1.7	33	19	13	APT25GN120BG	TO-247 or D3PAK
		1.7	46	24	17	APT35GN120BG	TO-247 or D3PAK
		1.7	66	32	22	APT50GN120B2G	T-MAX
		1.7	70	44	27	APT100GN120J	SOT-227
		1.7	99	45	30	APT75GN120B2G	T-MAX or TO-264
		1.7	120	58	38	APT100GN120B2G	T-MAX
		1.7	99	60	36	APT150GN120J	SOT-227
	600	Co-packaged (IGBT & "DQ" FRED)		15 kHz	30 kHz		
		1.5	24	15	10	APT20GN60BDQ1G	TO-247
		1.5	37	20	14	APT30GN60BDQ2G	TO-247
		1.5	64	30	21	APT50GN60BDQ2G	TO-247
		1.5	93	42	30	APT75GN60LDQ3G	TO-264
		1.5	123	75	47	APT150GN60JDQ4	SOT-227
		1.5	135	54	39	APT100GN60LDQ4G	TO-264
		1.5	190	79	57	APT150GN60LDQ4G	TO-264
		1.5	158	100	66	APT200GN60JDQ4	SOT-227
	1200			10 kHz	20 kHz		
		1.7	22	14	10	APT15GN120BDQ1G	TO-247 or D3PAK
		1.7	33	19	13	APT25GN120B2DQ2G	T-MAX
		1.7	46	24	17	APT35GN120L2DQ2G	264-MAX™
		1.7	57	36	22	APT75GN120JDQ3	SOT-227
		1.7	66	32	22	APT50GN120L2DQ2G	264-MAX
		1.7	70	44	27	APT100GN120JDQ4	SOT-227
		1.7	99	60	36	APT150GN120JDQ4	SOT-227

Part numbers for D3PAK packages—replace "B" with "S" in part number.
Part numbers for TO-264 packages—replace "B2" with "L" in part number.

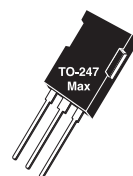
Current at frequency test conditions: T_J = 125°C, T_C = 100°C except SOT-227 where T_C = 80°C, V_{CC} = 67% rated voltage hard switch.



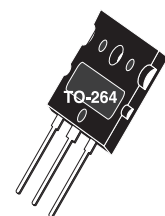
TO-247[B]



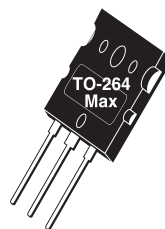
TO-268 (D3PAK) [S]



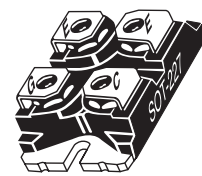
T-MAX®[B2]



TO-264[L]



264-MAX™[L2]



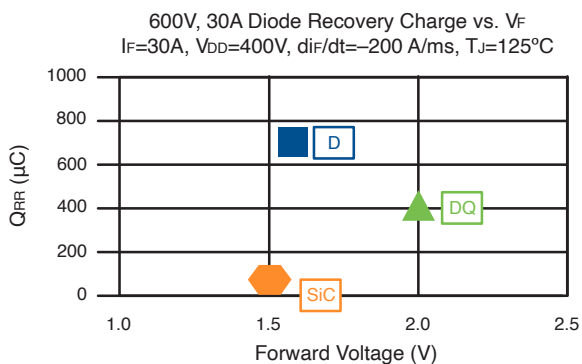
SOT-227[J]



Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

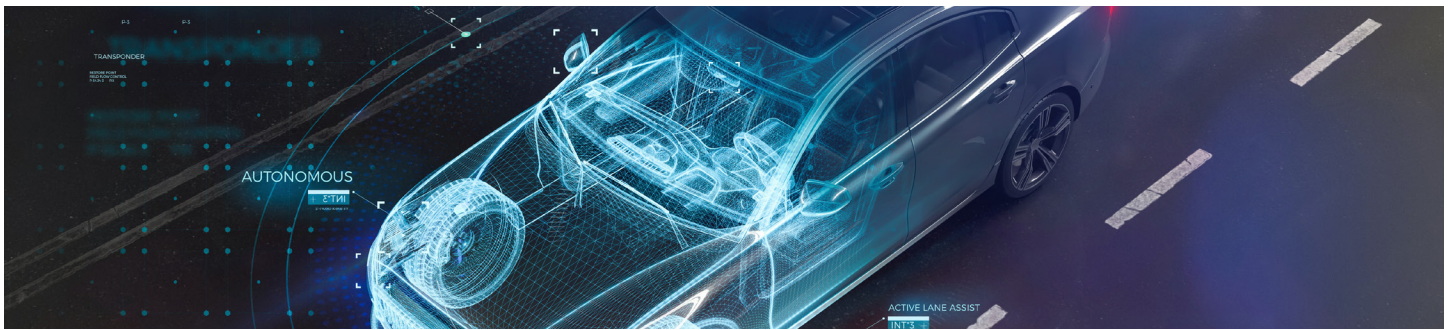
Microchip offers four series of discrete diode products: the medium-speed medium V_F D series, the high-speed DQ series, the silicon Schottky S series and the SiC Schottky Barrier Diode series. These series of diodes are designed to provide high-quality solutions to a wide range of high-voltage, high-power application requirements, ranging from fast recovery for continuous conduction mode power factor correction to low conduction loss for output rectification. The following table summarizes each product family's distinguishing features and potential applications.

The following graph shows the relative recovery speed and forward voltage positions of D, DQ, and SiC series diodes.



Fast, Ultra-Fast and Schottky Diodes

Series	Voltage Ratings	Features	Applications	Comment
D	200, 300, 400, 600, 1000, 1200	Medium V_F Medium speed	Freewheeling diode Output rectifier DC-DC converter	Proprietary platinum process
DQ	600, 1000, 1200	High speed Avalanche rated	PFC Freewheeling diode DC-DC converter	Stepped EPI improves softness Proprietary platinum process
Schottky	200	Low V_F Avalanche rated	Output rectifier Freewheeling diode DC-DC converter	
SiC Schottky	700, 1200, 1700, 3300	Zero reverse recovery	PFC Freewheeling diode DC-DC converter	Low switching losses, high power density and high-temperature operation

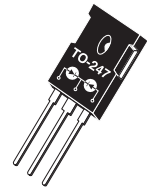


mSiC™ Diodes

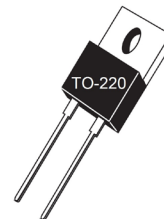
Part Number	Voltage (V)	I _F (A)	Package Style
MSC010SDA070B	700	10	TO-247-2
MSC010SDA070K		10	TO-220
MSC030SDA070B		30	TO-247-2
MSC030SDA070K		30	TO-220
MSC050SDA070B		50	TO-247-2
MSC010SDA120B	1200	10	TO-247-2
MSC010SDA120K		10	TO-220
MSC015SDA120B		15	TO-247-2
MSC015SDA120K		15	TO-220
MSC020SDA120B		20	TO-247-2
MSC020SDA120K		20	TO-220
MSC020SDA120S		20	D3PAK
MSC030SDA120B		30	TO-247-2
MSC030SDA120K		30	TO-220
MSC030SDA120S		30	TO-268
MSC050SDA120B	1700	50	TO-247-2
MSC050SDA120S		50	TO-268
MSC010SDA170B		10	TO-247-2
MSC030SDA170B	3300	30	TO-247-2
MSC050SDA170B		50	TO-247-2
MSC030SDA330B	700 Dual Diode (Common Cathode)	30	TO-247-2
MSC090SDA330B2		90	T-MAX®
MSC030SDA070BCT	1200 Dual Diode (Common Cathode)	2 × 30	TO-247
MSC050SDA070BCT		2 × 50	TO-247
MSC030SDA120BCT	700 Dual Diode (Anti-parallel/parallel)	2 × 30	TO-247
MSC050SDA120BCT		2 × 50	TO-247
MSC2X30/31SDA070J	1200 Dual Diode (Anti-parallel/parallel)	2 × 100	SOT-227
MSC2X50/51SDA070J		2 × 50	SOT-227
MSC2X100/101SDA070J		2 × 100	SOT-227
MSC2X30/31SDA120J	1700 Dual Diode (Anti-parallel/parallel)	2 × 30	SOT-227
MSC2X50/51SDA120J		2 × 50	SOT-227
MSC2X100/101SDA120J		2 × 100	SOT-227
MSC2X30SDA170J	700 Dual Diode (Anti-parallel/parallel)	2 × 30	SOT-227
MSC2X31SDA170J		2 × 30	SOT-227
MSC2X50SDA170J		2 × 50	SOT-227
MSC2X51SDA170J		2 × 50	SOT-227



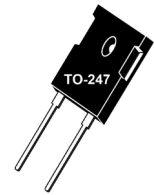
TO-268 (D3PAK) [S]



TO-247[BCT]
Common cathode



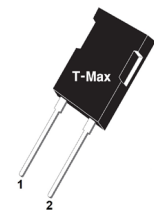
TO-220[K]



TO-247-2L[B]



SOT-227[J]
Antiparallel
Configuration
(Isolated Base)

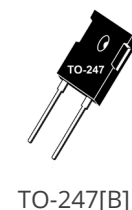


T-MAX®[B2]

Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

Volts	I (A)	Forward Voltage Typ 25°C	t(ns) Typ 25°C	Qrr (nC) Typ 125°C at I _F = I _F (avg)	Diode Series	Part Number	Package Style
Single							
1200	15	2.8	21	960	DQ	APT15DQ120BG 	TO-247
	15	2.8	21	960	DQ	APT15DQ120KG 	TO-220
	15	2.0	32	1300	D	APT15D120BG	TO-247
	15	2.0	32	1300	D	APT15D120KG	TO-220
	30	2.8	24	1800	DQ	APT30DQ120BG 	TO-247
	30	2.8	24	1800	DQ	APT30DQ120KG 	TO-220
	30	2.0	31	3450	D	APT30D120BG	TO-247 or D3PAK
	40	2.8	26	2200	DQ	APT40DQ120BG 	TO-247
						APT40DQ120SG	D3PAK
	60	2.8	30	2800	DQ	APT60DQ120BG 	TO-247
						APT60DQ120SG	D3PAK
	60	2.0	38	4000	D	APT60D120BG	TO-247 or D3PAK
	75	2.8	32	3340	DQ	APT75DQ120BG 	TO-247
						APT75DQ120SG	D3PAK
1000	15	2.5	20	810	DQ	APT15DQ100BG 	TO-247
	15	2.5	20	810	DQ	APT15DQ100KG 	TO-220
	15	1.9	28	1550	D	APT15D100BG	TO-247
	15	1.9	28	1550	D	APT15D100KG	TO-220
	30	2.5	22	1250	DQ	APT30DQ100BG 	TO-247
	30	2.5	22	1250	DQ	APT30DQ100KG 	TO-247
	30	1.9	29	2350	D	APT30D100BG	TO-247
	40	2.5	24	1430	DQ	APT40DQ100BG 	TO-247
	60	2.5	29	2325	DQ	APT60DQ100BG 	TO-247
	60	1.9	34	3600	D	APT60D100BG	TO-247 or D3PAK
	75	2.5	33	2660	DQ	APT75DQ100BG 	TO-247
600	15	2.0	16	250	DQ	APT15DQ60BG 	TO-247
						APT15DQ60SG	D3PAK
	15	2.0	16	250	DQ	APT15DQ60KG 	TO-220
	15	1.6	21	520	D	APT15D60BG	TO-247
	15	1.6	21	520	D	APT15D60KG	TO-220
	30	2.0	19	400	DQ	APT30DQ60BG 	TO-247
	30	2.0	19	400	DQ	APT30DQ60KG 	TO-220
	30	1.6	23	700	D	APT30D60BG	TO-247 or D3PAK
	40	2.0	22	480	DQ	APT40DQ60BG 	TO-247
	60	2.0	26	640	DQ	APT60DQ60BG 	TO-247
						APT60DQ60SG	D3PAK
	60	1.6	40	920	D	APT60D60SG	D3PAK
	75	2.0	29	650	DQ	APT75DQ60BG 	TO-247
						APT75DQ60SG	D3PAK
400	15	1.3	19	300	D	APT15D40KG	TO-220
	30	1.3	22	360	D	APT30D40BG	TO-247
	60	1.3	30	540	D	APT60D40BG	TO-247
200	30	1.1	21	150	D	APT30D20BG	TO-247
	30	0.83	25	448	Schottky	APT30S20BG	TO-247 or D3PAK
	60	1.1	30	250	D	APT60D20BG	TO-247
	60	0.83	35	490	Schottky	APT60S20BG	TO-247 or D3PAK
	100	0.89	40	690	Schottky	APT100S20BG	TO-247

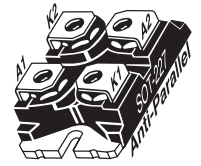
Part numbers for D3PAK—replace “B” with “S” in part number.



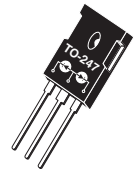
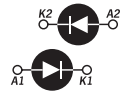
Si Schottky Barrier Diodes, Fast and Ultra-Fast Recovery Diodes

Volts	I (A)	Forward Voltage Typ 25°C	t(ns) Typ 25°C	Qrr (nC) Typ 125°C at I _F = I _F (avg)	Diode Series	Part Number	Package
Dual							
1200	2x27	2	31	3450	D	APT2X30D120J	SOT-227
	2x30	2.6	25	1800	DQ	APT2X30DQ120J	SOT-227
	2x53	2.0	38	4000	D	APT2X60D120J	SOT-227
	2x60	2.5	30	2890	DQ	APT2X60DQ120J	SOT-227
	2x93	2.0	47	5350	D	APT2X100D120J	SOT-227
	2x100	2.4	45	5240	DQ	APT2X100DQ120J	SOT-227
1000	2x28	1.9	29	2350	D	APT2X30D100J	SOT-227
	2x55	1.9	34	3600	D	APT2X60D100J	SOT-227
	2x60	2.2	30	2350	DQ	APT2X60DQ100J	SOT-227
	2x95	1.9	43	4050	D	APT2X100D100J	SOT-227
	2x100	2.1	45	3645	DQ	APT2X100DQ100J	SOT-227
	2x30	1.8	20	400	DQ	APT2X30DQ60J	SOT-227
600	2x30	1.6	23	700	D	APT2X30D60J	SOT-227
	2x60	1.7	27	650	DQ	APT2X60DQ60J	SOT-227
	2x60	1.6	40	920	D	APT2X60D60J	SOT-227
	2x100	1.6	30	980	DQ	APT2X100DQ60J	SOT-227
	2x100	1.6	34	1450	D	APT2X100D60J	SOT-227
	2x30	1.3	22	360	D	APT2X30D40J	SOT-227
400	2x60	1.3	30	540	D	APT2X60D40J	SOT-227
	2x100	1.3	37	1050	D	APT2X100D40J	SOT-227
	2x30	1.2	20	150	D	APT2X30D30J	SOT-227
300	2x60	1.2	29	370	D	APT2X61D30J	SOT-227
	2x100	1.2	36	650	D	APT2X101D30J	SOT-227
	2x30	1.1	21	150	D	APT2X30D20J	SOT-227
200	2x60	1.1	30	250	D	APT2X61D20J	SOT-227
	2x30	0.80	25	448	Schottky	APT2X31S20J	SOT-227
	2x60	0.83	35	490	Schottky	APT2X61S20J	SOT-227
	2x100	1.1	39	840	D	APT2X100D20J	SOT-227
	2x100	0.89	40	690	Schottky	APT2X101S20J	SOT-227
	2x30	2.8	26	2100	DQ	APT30DQ120BCTG	TO-247 [BCT]
1000	2x15	2.5	20	810	DQ	APT15DQ100BCTG	TO-247 [BCT]
	2x15	1.9	28	1550	D	APT15D100BCTG	TO-247 [BCT]
	2x15	1.9	28	1550	D	APT15D100BHBG	TO-247 [BHB]
	2x18	1.9	29	2350	D	APT30D100BCAG	TO-247 [BCA]
	2x30	1.9	29	2360	D	APT30D100BCTG	TO-247 [BCT]
	2x30	1.9	30	2350	D	APT30D100BHBG	TO-247 [BHB]
	2x40	2.5	25	1650	DQ	APT40DQ100BCTG	TO-247 [BCT]
	2x60	2.5	29	2325	DQ	APT60DQ100LCTG	TO-264 [LCT]
	2x60	1.9	35	3600	D	APT60D100LCTG	TO-264 [LCT]
600	2x15	1.6	21	520	D	APT15D60BCTG	TO-247 [BCT]
	2x15	2.0	15	250	DQ	APT15DQ60BCTG	TO-247 [BCT]
	2x15	1.6	20	520	D	APT15D60BCAG	TO-247 [BCA]
	2x30	2.0	22	480	DQ	APT30DQ60BHBG	TO-247 [BHB]
	2x30	2.0	19	400	DQ	APT30DQ60BCTG	TO-247 [BCT]
	2x30	1.6	23	700	D	APT30D60BCTG	TO-247 [BCT]
	2x30	1.6	25	700	D	APT30D60BHBG	TO-247 [BHB]
	2x30	1.6	25	700	D	APT30D60BCAG	TO-247 [BCA]
	2x40	2.0	22	480	DQ	APT40DQ60BCTG	TO-247 [BCT]
	2x60	2.0	26	640	DQ	APT60DQ60BCTG	TO-247 [BCT]
400	2x60	1.6	30	920	D	APT60D60LCTG	TO-264 [LCT]
	2x15	1.3	19	300	D	APT15D40BCTG	TO-247 [BCT]
	2x30	1.3	22	360	D	APT30D40BCTG	TO-247 [BCT]
	2x60	1.3	30	540	D	APT60D40LCTG	TO-264 [LCT]
	2x30	1.2	25	1300	D	APT30D30BCTG	TO-247 [BCT]
	2x30	1.1	21	150	D	APT30D20BCTG	TO-247 [BCT]
200	2x30	1.1	21	150	D	APT30D20BCAG	TO-247 [BCA]
	2x30	0.80	25	448	Schottky	APT30S20BCTG	TO-247 [BCT]
	2x60	0.83	35	490	Schottky	APT60S20B2CTG	T-MAX® [B2CT]
	2x100	0.89	40	690	Schottky	APT100S20LCTG	TO-264 [LCT]
	2x30	1.1	21	150	D	APT30D20BCTG	TO-247 [BCT]

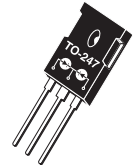
Part numbers for parallel configuration: replace 30, 60, or 100 with 31, 61, or 101, unless Schottky.
Example: 2X30D120J becomes 2X31D120J.



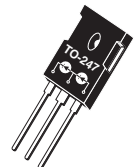
SOT-227[J]
Antiparallel
Configuration
(Isolated Base)



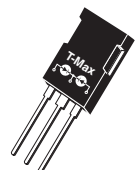
TO-247[BCA]
Common anode



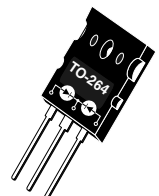
TO-247[BCT]
Common cathode



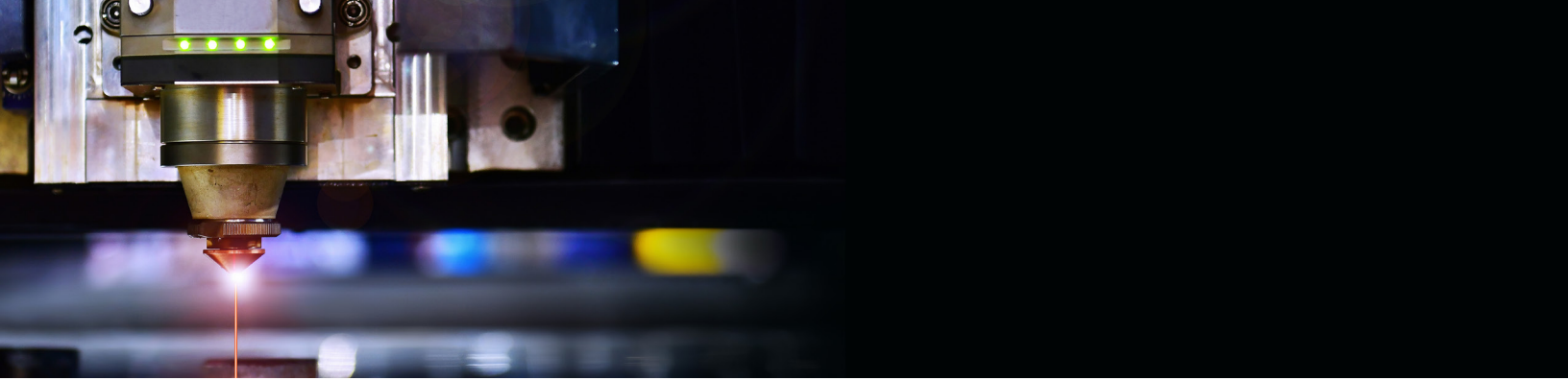
TO-247[BHB]
Half-bridge



T-MAX® [B2CT]
Common cathode



TO-264[LCT]
Common cathode



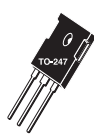
High-Voltage RF MOSFETs

The ARF family of RF power MOSFETs is optimized for applications requiring frequencies as high as 150 MHz and operating voltages as high as 400V. Historically, RF power MOSFETs were limited to applications of 50V or less. This limitation has been removed by combining Microchip’s high-voltage MOSFET technology with RF-specific die geometries.

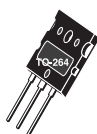
Higher V_{DD} means higher load impedance. For 150W output from a 50V supply, the load impedance is only 8 Ω . At 125V,

the load impedance is 50 Ω . The higher impedance allows simpler transformers and combiners. Paralleled devices can operate into reasonable and convenient impedances. The increased operating voltage also lowers the DC current required for any given power output, increasing efficiency and reducing the size, weight and cost of other system components. High breakdown voltage is a necessity in high-efficiency switchmode amplifiers, such as class C-E, which can see peak drain voltages of over 4x the applied V_{DD} .

Part Number	P _{OUT} (W)	Freq. (MHz)	V _{DD} /V _{BR(DSS)} (V)	R _{thjc} (°C/W)	Package Style	Class of Operation
ARF449AG/BG	90	120	150/450	0.76	TO-247	A-E
ARF460AG/BG	150	65	125/500	0.5	TO-247	A-E
ARF461AG/BG	150	65	250/1000	0.5	TO-247	A-E
ARF463AG/BG	100	100	125/500	0.7	TO-247	A-E
ARF463AP1G/BP1G	100	100	125/500	0.7	TO-247	A-E
ARF465AG/BG	150	60	300/1200	0.5	TO-247	A-E
ARF466AG/BG	300	45	200/1000	0.35	TO-264	A-E
ARF466FL	300	45	200/1000	0.13	T3A	A-E
ARF468AG/BG	300	45	150/500	0.35	TO-264	A-E
ARF469AG/BG	350	45	165/500	0.28	TO-264	A-E
ARF475FL	450	150	165/500	0.17	T3A	A-E
ARF476FL	300	150	165/500	0.31	T3	A-E
ARF477FL	400	100	165/500	0.20	T3C	A-E
ARF1500	750	40	125/500	0.10	T1	A-E
ARF1501	750	40	250/1000	0.10	T1	A-E
ARF1510	750	40	400/1000	0.10	T1A	D
ARF1511	750	40	380/500	0.10	T1A	D
ARF1519	750	25	250/1000	0.13	T2	A-E



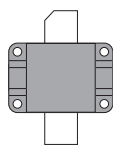
TO-247



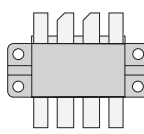
TO-264



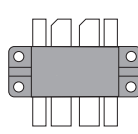
T1



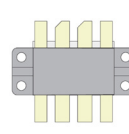
T2



T3



T3A



T3C

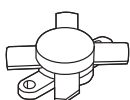


High-Frequency RF MOSFETs

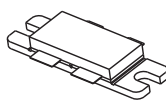
The VRF family of RF MOSFETs includes improved replacements for industry-standard RF transistors. They provide improved ruggedness by increasing the Drain-Source Breakdown Voltage [$V_{BR(DSS)}$] over 30 percent from the industry-standard 125V to 170V minimum. Low-cost

flangeless packages are another improvement that shows Microchip's dedication to optimizing performance, reducing cost and improving reliability. We will continue to offer more products with the new reduced-cost flangeless packages.

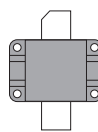
Part Number	P _{OUT} (W)	Freq. (MHz)	Gain Typ (dB)	Eff. Typ (%)	V _{DD} /V _{BR(DSS)} (V)	R _{thjc} (°C/W)	Package Style
VRF141	150	175	13	45	28/80	0.60	M174
VRF151	150	175	14	50	20/170	0.60	M174
VRF152	150	175	14	50	50/130	0.60	M174
VRF150	150	150	11	50	50/170	0.60	M174
VRF161	200	150	14	50	50/170	0.50	M174
VRF141G	300	175	14	55	28/80	0.35	M208
VRF151G	300	175	16	55	50/170	0.35	M208
VRF152G	300	175	16	55	50/130	0.35	M208
VRF2933	300	150	22	50	50/170	0.27	M177
VRF2944	400	150	25	50	65/170	0.22	M177
VRF154FL	600	30	17	45	50/170	0.13	T2
VRF157FL	600	30	21	45	50/170	0.13	T2
VRF164FL	600	30	21	45	65/170	0.10	T2



M113/M174/
M177



M208



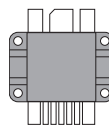
T2

Drivers and Driver-RF MOSFET Hybrids

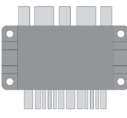
The DRF1200/01 hybrids integrate drivers, bypass capacitors and RF MOSFETs into a single package. Integration maximizes amplifier performance by minimizing transmission line parasitics between the driver and the MOSFET. The DRF1300 and DRF1301 have two independent channels, each containing a driver and RF MOSFET in a push-pull configuration.

The DRF1400 is a half-bridge hybrid with symmetrically oriented leads that can be easily configured into a full-bridge converter. The DRF1510 is a full bridge product optimized for maximum efficiency in class D amplifiers. All DRF parts feature a proprietary anti-ring function to eliminate cross conduction in bridge or push-pull topologies.

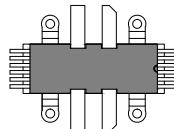
Part Number	P _{OUT} (W)	Freq. (MHz)	V _{DD} /V _{BR(DSS)} (V)	Package Style	Class of Operation
DRF1200	600	30	15/1000	T2B	D-E
DRF1201	1000	30	15/1000	T2B	D-E
DRF1300	1000	30	15/500	T4	D-E
DRF1301	1000	30	15/1000	T4	D-E
DRF1400	1000	30	15/500	T4	D-E
DRF1211	1000	30	15/1000	T2B	D-E
DRF1311	1000	30	15/1000	T4	D-E
DRF1410	1000	30	15/500	T4A	D-E
DRF1510	2000	30	15/500	T102	D-E



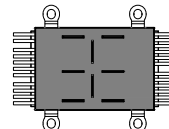
T2B



T4



T4A



T102

RF Reference Designs

[DRF1200/CLASS-E, 13.56 MHz](#) [DRF1200/CLASS-E, 27.12 MHz](#)

The DRF1200/Class-E single-ended RF generator is a reference design that allows the designer to evaluate an 85 percent efficient 1000W Class-E RF generator.

[DRF1300/CLASS-D, 13.56 MHz](#)

The DRF1300/Class-D push-pull RF generator is a reference design that allows the designer to evaluate an 80-percent efficient 2000W Class-D RF generator.

[DRF1400/Class-D, 13.56 MHz](#)

The DRF1400/Class-D half-bridge RF generator is a reference design that allows the designer to evaluate an 85-percent efficient 2500W Class-D RF generator.

Reference Design Kits

All kits include a fully populated board attached to an aluminum heat sink, an extensive application note explaining the theory of operation with designer's recommendations for evaluation and board layout, and all key waveforms illustrated and described. A complete parts list with recommended vendor part numbers and the board's Gerber file are provided for an easy transition into an end application.

[DRF1200/CLASS-E, 13.56 MHz and](#) [DRF1200/CLASS-E, 27.12 MHz](#)

The DRF1200/Class-E single-ended RF generator is a reference design that allows the designer to evaluate an 85 percent efficient 1000W Class-E RF generator.

[DRF1300/CLASS-D, 13.56 MHz](#)

The DRF1300/Class-D push-pull RF generator is a reference design that allows the designer to evaluate an 80-percent efficient 2000W Class-D RF generator.

[DRF1400/Class-D, 13.56 MHz](#)

The DRF1400/Class-D half-bridge RF generator is a reference design that allows the designer to evaluate an 85-percent efficient 2500W Class-D RF generator.

mSiC Bare Die

mSiC™ Bare Die MOSFETs

Part Number	Voltage (V)	$R_{DS(on)}$ (mΩ)	Package
MSC015SMA070D/S 	700	15	Die
MSC035SMA070D/S 		35	Die
MSC060SMA070D/S 		60	Die
MSC090SMA070D/S 		90	Die
MSC017SMA120D/S 	1200	17	Die
MSC025SMA120D/S 		25	Die
MSC040SMA120D/S 		40	Die
MSC080SMA120D/S 		80	Die
MSC180SMA120D/S 		180	Die
MSC360SMA120D/S 		360	Die
MSC035SMA170D/S	1700	35	Die
MSC750SMA170D/S		750	Die
MSC025SMA330D/S	3300	25	Die
MSC027SMA330D/S		27	Die
MSC080SMA330D/S		80	Die
MSC400SMA330D/S		400	Die

mSiC Bare Die Diodes

Part number	Voltage (V)	Current (A)	Package
MSC010SDA070D/S 	700	10	Die
MSC030SDA070D/S 		30	Die
MSC050SDA070D/S 		50	Die
MSC010SDA120D/S 	1200	10	Die
MSC015SDA120D/S 		15	Die
MSC020SDA120D/S 		20	Die
MSC030SDA120D/S 		30	Die
MSC050SDA120D/S 		50	Die
MSC010SDA170D/S	1700	10	Die
MSC030SDA170D/S		30	Die
MSC050SDA170D/S		50	Die
MSC030SDA330D/S	3300	30	Die
MSC090SDA330D/S		90	Die

Power Modules



Microchip combines a formidable array of technologies in semiconductors, packaging and automated manufacturing to produce a wide range of high-quality modules optimized for the following traits:

- Reliability
- Efficiency and electrical performance
- Low cost
- Space savings
- Reduced assembly time

The readily available standard module product line spans a wide selection of semiconductor (including Silicon Carbide) circuit topologies, voltage and current ratings, and packages. If you need even more flexibility or intellectual property protection, we can customize a standard module with a low setup cost and short lead time. Unique requirements can be met with Application Specific Power Modules (ASPM).

Microchip serves a broad spectrum of industrial applications for welding, solar, induction heating, medical, UPS, motor control and SMPS markets as well as high-reliability applications for semicap, defense and aerospace markets. A wide selection of construction materials enables Microchip to manufacture modules with the following features:

- Extended temperature range: -60°C to 200°C
- High-reliability
- Reduced size and weight
- High-reliability testing and screening options
- Short lead times

Microchip's experience and expertise in power electronic conversion brings the most effective technical support for your new development.

- Isolated gate driver
- Snubbers
- Mix-and-match semiconductors
- Short-circuit protection
- Temperature and current sensing
- Parameter binning

Standard Electrical Configurations

Microchip offers a wide range of standard electrical configurations housed in a variety of packages to match your specific needs for high power-density and performance. Various semiconductor types are offered in the same topology.

Electrical Topology	IGBT 600V–1700V	MOSFET 75V–1200V	Diode 200V–1700V	Mix Si-SiC 600V–1200V	Full SiC 600V–1700V	Digital Gate Driver
Asymmetrical bridge	•	•				
Boost buck	•	•				
Boost and buck chopper	•	•		•	•	•
Common anode			•			
Common cathode			•			
Dual boost and buck chopper	•	•		•		
Dual common source	•	•				
Dual diode					•	•
Full bridge	•	•	•		•	•
Full bridge with PFC	•	•		•		
Full bridge with secondary fast rectifier bridge	•	•		•		
Full bridge with series and parallel diodes		•		•		
Interleaved PFC	•	•				
Linear single and dual switch		•				
Phase leg	•	•	•		•	•
Phase leg intelligent	•					
Phase leg with PFC		•		•		
Phase leg with series and parallel diodes		•		•		
Single switch	•	•	•			
Single switch with series and parallel diodes		•		•		
Single switch with series diodes	•	•				
3-Level NPC inverter	•				•	•
3-Level T-Type inverter	•			•	•	•
3-Phase bridge	•		•			
Triple dual common source	•	•				
Triple phase leg	•	•		•	•	•
	Trench 3	MOSFET	FRED	IGBT	Diode	Gate Driver Core
	Trench 4	FREDFET	Std Rectifier	MOSFET	MOSFET	Module Adapter Board
	Trench 4 Fast	Superjunction MOSFET		Diode		Plug and Play Driver
	Trench 5					Developer Kit

Package Advantages

SP1F package

- Replaces two SOT-227 parts
- Improved assembly time and cost
- Height compatible with SOT-227
- Copper base plate

SP3F package

- Replaces up to four SOT-227 parts
- Reduced assembly time and cost
- Height compatible with SOT-227
- Copper base plate

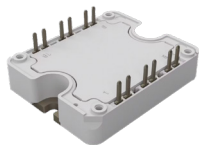
SP6C package

- Offers the same footprint and the same pinout location as the popular 62 mm package but with lower height, giving it the following advantages:
 - Reduced stray inductance
 - Reduced parasitic resistance
 - Higher efficiency at high frequency

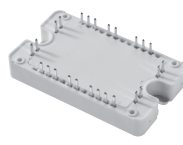
SP6-P package

- Replaces up to six SOT-227 parts
- Height compatible with SOT-227
- Low-inductance solder pins
- High current capability

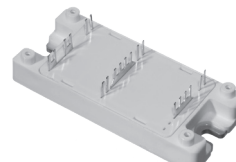
Improved Low-Profile Packages



SP1F



SP3F (12 mm)



SP4 (17 mm)



D1P (17 mm)



SP6C (17 mm)



SP6-P (12 mm)



SP6LI (17 mm)

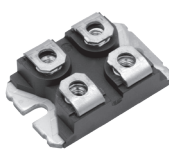


LP4



SP3X

Industry-Standard Packages



SOT-227



D3 (62 mm wide)



D4 (62 mm wide)

High Reliability Baseplate-less Packages



BL1 (9.3 mm)



BL2 (9.3 mm)



BL3 (9.3 mm)

Custom Power Modules

Microchip created the Active-state power management (ASPM) concept, and has been offering customized power modules since 1983. We offer a complete engineered solution with mix-and-match capabilities in term of package, configuration, performance and cost.

Internal Printed Circuit Board

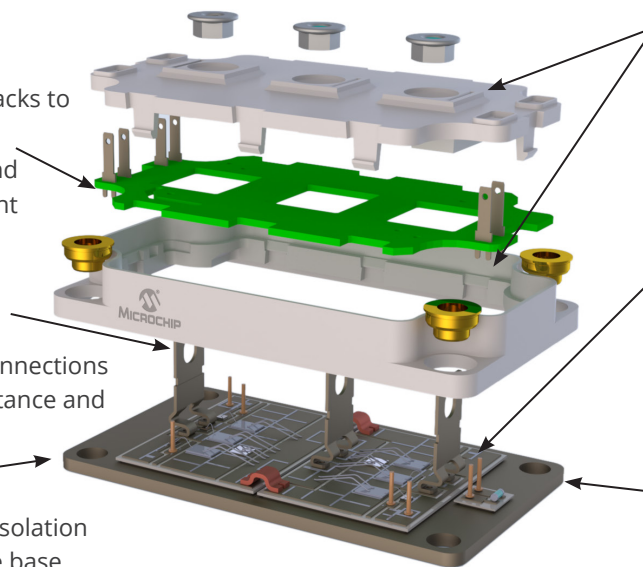
- Not available in all modules
- Used to route gate signals' tracks to small signal terminals
- Used to mount gate circuit and protection in case of intelligent power module

Terminals

- Screw-on or solder pins
- Provides power and signal connections with minimum parasitic resistance and inductance

Substrates

- Al_2O_3 , AlN , and Si_3N_4 provide isolation and good heat transfer to the base plate



Package

- Standard or custom
- Ensures environmental protection and mechanical robustness

Power Semiconductor Die

- IGBT, MOSFET, diode, SiC, thyristor and switching devices soldered to the substrates and connected by ultrasonic aluminum wire bonds

Base Plate

- Improves the heat transfer to the heat sink
- Copper for good thermal transfer
- AlSiC, CuW and CuMoCu for improved reliability

Rugged Custom Versions (Available on Demand):

The standard power module products listed in this catalog are dedicated to industrial applications.

For more severe environmental conditions/requirements, we can propose rugged custom versions (derived from the existing standard products) using specific materials, including Aerospace-grade versions managed under AS9100 Quality Standards, with:

- AlSiC baseplate (instead of copper) for about (6×) higher power cycling capabilities
- Si_3N_4 AMB substrates or AlN DBC substrates (instead of Al_2O_3) for (20%) improved thermal conductivity
- Extended temperature raw materials to address wider temperature range applications (from -60°C Storage ; -55°C to +125°C Operating)

Easy Mounting Solutions With Press-Fit Versions (Available on Demand):

To facilitate the design, the assembly, and repair of your systems, our SP1F and SP3F package type products can be available with Press-Fit terminals.

mSiC MOSFET Modules Without Parallel mSiC Diodes (Available on Demand):

If applicable with your application (for cost saving), the mSiC MOSFET products featuring a parallel mSiC diode, listed in this catalog, can be available without.

Custom Power Modules

The following table shows the three customization levels.

Change Options:	Die	Substrate	Base Plate	Plastic Lid	Terminals	NRE Level	MOQ
Electrical/thermal performance	Die P/N	Material	Material			None to low	5 to 10 pieces
Electrical/thermal performance and electrical configuration	Die P/N	Material and layout	Material			Low to medium	
Electrical/thermal performance, and electrical configuration, and module housing	Die P/N	Material and layout	Material and shape	Material and shape	Shape	Medium to high	

Microchip power modules are made of different sub-elements. Most of them are standard and can be reused to build infinite solutions for the end user. Microchip offers optimum development cost and cycle time thanks to long-term experience and a wide range of available technologies.

Power Modules Features

- High power density
- Isolated and highly thermally-conductive substrate
- Internal wiring
- Minimum parasitics
- Minimum output terminals
- Mix-and-match components
- Fully engineered solutions

Customer Benefits

- Size and cost reduction
- Excellent thermal management
- Reduced external hardware
- Improved performance
- Reduced assembly time
- Optimizes losses
- Easy to upgrade, lower part count, shorter time to market and IP protection

Rugged Custom Power Modules

Various proposed solutions offer different costs and low volume of entry

	Industrial Application	Extended Temp. Application	Harsh Environment Application	
Standard module	•			No NRE Low-volume entry
Modified standard module	•	•		Low NRE Low-volume entry
Custom module	•	•	•	Medium to high NRE Low-volume entry

Flexibility

- Great level of integration
- Mix of silicon within the same package
- No quantity limitation

Technology

- Application oriented

Packaging Capability

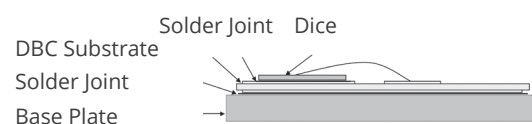
- Standard and custom packages
- Standard and custom terminals
- Various substrate technologies

Reliability

- Coefficient of thermal expansion matching

Applications

- Solar, welding, plasma cutting, semicap, MRI and X-ray, EV/HEV, induction heating, UPS, motor control, data communication





Rugged Custom Power Modules

Microchip has acquired much experience and know-how in module customization that addresses rugged and wide temperature range applications, offering solutions to meet the expectations of next-generation integrated power systems for the following attributes:

- Improved reliability
- Wider operating temperatures
- Higher power
- Higher efficiency
- Lower weight and size
- Lower cost

Applications

- Avionics actuation system
- Avionics lift and pump
- Military ground vehicle
- Power supply and motor control
- Navy ship auxiliary power supply
- Down hole drilling

Test Capabilities

- X-Ray inspection
- Dielectric test (up to 6 kV)
- Electrical testing at specified temperature
- Burn-in
- Acoustic imaging

Reliability Testing Capabilities

- Power cycling
- Hermetic sealing
- Moisture
- Salt atmosphere
- HTGB
- Temperature shock
- HAST
- H3TRB
- Altitude
- Mechanical shock, vibration

Expertise Capabilities

- Cross-sectioning
- Structural analysis

All tests can be conducted upon demand by sampling or at 100 percent. Tests can be performed in-house or in an external lab.

Our Core Competencies

- Extensive experience with rugged solutions for harsh environments
- Wide range of silicon technologies
- Wafer fab capabilities
- Mix of assembly technologies
- Hermetic and robust plastic packages
- Custom test and burn-in solutions
- ISO9001-certified
- End-of-life (obsolescence) management
- Thermal management
- Material expertise
- Product life management and risk analysis



Module performance and reliability depends on the choice of assembly materials

Temperature Coefficients of Expansion (TCEs) with more closely matched materials increase the module's lifetime by reducing the stress at both the interface and interior of the materials.

The higher the thermal conductivity, the lower the junction-to-case thermal resistance and the lower the delta of junction temperature of the device during operation. This will minimize the effect of power cycling on the dice.

Another important feature is the material density, particularly for the baseplate. Taking copper as the reference, AlSiC has a density of 1/3, while CuW has twice the density. Therefore, AlSiC will provide substantial weight reduction while increasing reliability.

	CTE (ppm/K)	Thermal Conductivity (W/m.K)	R _{θJC} or R _{THJC} (K/W)
Silicon die (120 mm²)	4	136	
Cu/Al2O3	17/7	390/25	0.35
AlSiC/Al2O3	7/7	170/25	0.38
Cu/AlN	17/5	390/170	0.28
AlSiC/AlN	7/5	170/170	0.31
AlSiC/Si3N4	7/3	170/60	0.31

	Material	CTE (ppm/K) (W/m.K)	Thermal Conductivity	Density (g/cc)
Base plate	CuW	6.5	190	17
	AlSiC	7	170	2.9
	Cu	17	390	8.9
Substrate	Al2O3	7	25	
	AlN	5	170	
	Si3N4	3	60	
Die	Si	4	136	
	SiC	2.6	270	

Power Module Part Numbering System

IGBT Modules

APT MSC	GL	475	A	120	T	D3	G
I	II	III	IV	V	VI	VII	VIII

I	TradeMark
II	IGBT Type: GL = Trench 4 GLQ = High-speed Trench 4 GT = Trench 3 GTQ = Trench 5 GV = Mix NPT/Trench CV = Mix Trench/Superjunction MOSFET
III	Current: I_c at $T_c = 80^\circ\text{C}$
IV	Topology: A = Phase Leg BB = Boost Buck DA = Boost Chopper DDA = Double Boost Chopper DH = Asymmetrical Bridge DSK = Double Buck Chopper DU = Dual Common Source H = Full Bridge HR = T-Type 3-Level SDA = Double Boost + Bypass Diode SK = Buck Chopper TA = Triple Phase Leg TDU = Triple Dual Common Source TL = Three Level U = Single Switch VDA = Interleaved PFC X = Three Phase Bridge
V	Blocking Voltage: 60 = 600V 120 = 1200V 170 = 1700V
VI	Option: A = AlN Substrate C = mSiC Diode D = Series Diode E = PressFit T = Temperature Sensor W = Clamping Parallel Diode
VII	Package: 1 = SP1, SP1F 3 = SP3F P = SP6-P D3 = D3 (62 mm) D4 = D4 (62 mm) BL1, BL2, BL3 (Baseplate-less)
VIII	G = RoHS-compliant

MOSFET Modules

APT MSC	C	60	DA	M24	T	1	G
I	II	III	IV	V	VI	VII	VIII

I	TradeMark
II	MOSFET Type: SM = mSiC MOSFET M = MOSFET C = Superjunction MOSFET
III	Blocking Voltage: 08 = 75V 10 = 100V 20 = 200V 50 = 500V 60 = 600V 70 = 700V 80 = 800V 100 = 1000V 120 = 1200V 170 = 1700V
IV	Topology: A = Phase Leg BB = Boost Buck DA = Boost Chopper DDA = Double Boost Chopper DH = Asymmetrical Bridge DSK = Double Buck Chopper DU = Dual Common Source H = Full Bridge HR = T-Type 3-Level SB = D2MAX SDA = Double Boost and Bypass Diode SK = Buck Chopper TA = Triple Phase Leg TDU = Triple Dual Common Source TL = Three Level NPC U = Single Switch VDA = Interleaved PFC
V	$R_{DS(on)}$ at $T_c = 25^\circ\text{C}$ 240 = 2400 m Ω 24 = 240 m Ω M24 = 24 m Ω
VI	Option: A = AlN Substrate C = mSiC Diode D = Series Diode E = PressFit F = FREDFET S = Series and Parallel Diodes T = Temperature Sensor U = Ultra-fast FREDFET
VII	Package: 1 = SP1, SP1F 3 = SP3F P = SP6-P LI = SP6LI BL1, BL2, BL3 (Baseplate-less)
VIII	G = RoHS-compliant

Diode Modules

APT MSC	DR	90	X	160	1	G
I	II	III	IV	V	VI	VII

I	TradeMark
II	Diode Type: DF = FRED DR = Standard Rectifier DC = mSiC Diode DSK = Schottky
III	Current: I_F at $T_c = 80^\circ\text{C}$
IV	Topology: AA = Dual Common Anode BB = Boost Buck AK = Dual Series KK = Dual Common Cathode H = Single Phase Bridge U = Single Switch X = Three Phase Bridge
V	Blocking Voltage: 20 = 200V 40 = 400V 60 = 600V 70 = 700V 100 = 1000V 120 = 1200V 160 = 1600V 170 = 1700V
VI	Option: E = PressFit Package: 1 = SP1, SP1F 3 = SP3F D1P = D1P BL1, BL2, BL3 (Baseplate-less)
VII	G = RoHS-compliant

Optional Materials

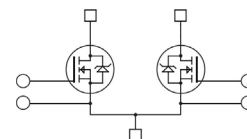
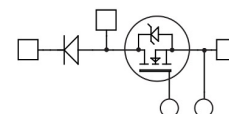
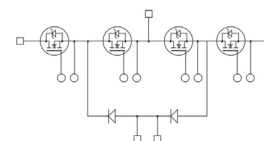
Optional materials are available upon demand for most of the listed standard power modules. Options are indicated with a letter in the suffix of the module part number. The temperature sensor option is listed as "YES" or "OPTION" when available for a standard part or on-demand.

The following tables list the options available for our product categories.

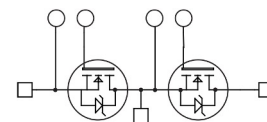
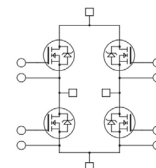
A	AlN substrate for higher thermal conductivity
M	AlSiC base plate material for improved temperature cycling capabilities
T	Temperature sensor (NTC or PTC) for case temperature information
C	mSiC diode for higher efficiency
N	Si3N4 substrate
E	Press fit terminals (for SP1F and SP3F package only)
X	Gold pin terminals (SP1 only)
L	Phase change material option

mSiC™ MOSFET Modules

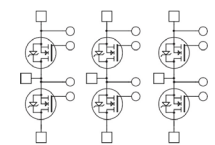
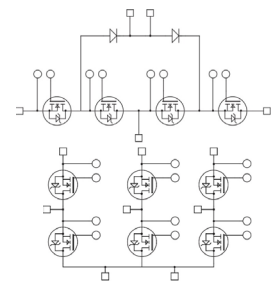
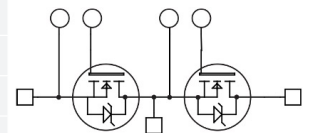
Part Number	Configuration	V _{DSS} (V)	R _{DS(ON)} (mΩ)	Current (A)	Package	Plug and Play Driver
MSCSM70TLM05CAG	3 Level Inverter	700	3.8	369	SP6C	
MSCSM70TLM07CAG			5	278	SP6C	
MSCSM70TLM10C3AG			7.5	191	SP3F	
MSCSM70TLM19C3AG			15	98	SP3F	
MSCSM120TLM08CAG		1200	6.25	265	SP6C	
MSCSM120TLM11CAG			8.3	200	SP6C	
MSCSM120TLM16C3AG			12.5	138	SP3F	
MSCSM120TLM31C3AG			25	71	SP3F	
MSCSM120TLM50C3AG		1700	40	44	SP3F	
MSCSM170TLM11CAG			8.8	189	SP6C	
MSCSM170TLM15CAG			11.7	142	SP6C	
MSCSM170TLM23C3AG			17.5	98	SP3F	
MSCSM170TLM45C3AG			35	51	SP3F	
MSC100SM70JCU2	Boost Chopper	700	15	97	SOT-227	
MSCSM120DAM11CT3AG		1200	11	202	SP3F	
MSC130SM120JCU2			12.5	138	SOT-227	
MSC70SM120JCU2			25	71	SOT-227	
MSC40SM120JCU2			40	44	SOT-227	
MSC100SM70JCU3	Buck Chopper	700	15	97	SOT-227	
MSCSM120SKM11CT3AG		1200	11	202	SP3F	
MSC130SM120JCU3			12.5	138	SOT-227	
MSC70SM120JCU3			25	71	SOT-227	
MSC40SM120JCU3			40	44	SOT-227	
MSCSM70DUM017AG	Dual Common Source	700	1.7	812	SP6C	
MSCSM70DUM025AG			2.5	548	SP6C	
MSCSM70DUM07T3AG			5	281	SP3F	
MSCSM70DUM10T3AG			7.5	191	SP3F	
MSCSM120DUM027AG		1200	2.8	584	SP6C	
MSCSM120DUM042AG			4.2	394	SP6C	
MSCSM120DUM08T3AG			6.25	268	SP3F	
MSCSM120DUM11T3AG			8.3	202	SP3F	
MSCSM120DUM16T3AG		1700	12.5	138	SP3F	
MSCSM170DUM039AG			3.9	416	SP6C	
MSCSM170DUM058AG			5.8	281	SP6C	
MSCSM170DUM11T3AG			8.8	191	SP3F	
MSCSM170DUM15T3AG			11.6	144	SP3F	
MSCSM170DUM23T3AG			17.5	98	SP3F	



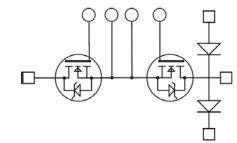
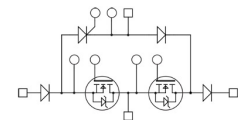
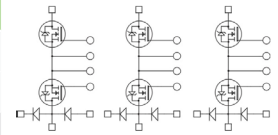
Part Number	Configuration	V _{DS} (V)	R _{DS(ON)} (mΩ)	Current (A)	Package	Plug and Play Driver
MSCSM70HM038AG	Full Bridge	700	3.8	369	SP6C	
MSCSM70HM038CAG					SP6C	
MSCSM70HM05AG			5	278	SP6C	
MSCSM70HM05CAG					SP6C	
MSCSM70HM19CT3AG			15	97	SP3F	
MSCSM70HM19T3AG				98	SP3F	
MSCSM120HM063AG		1200	6.3	265	SP6C	
MSCSM120HM063CAG					SP6C	
MSCSM120HM083AG			8.3	200	SP6C	
MSCSM120HM083CAG					SP6C	
MSCSM120HM16T3AG			12.5	138	SP3F	
MSCSM120HM16CT3AG					SP3F	
MSCSM120HM31T3AG			25	71	SP3F	
MSCSM120HM31CT3AG					SP3F	
MSCSM120HM50T3AG			40	44	SP3F	
MSCSM120HM50CT3AG					SP3F	
MSCSM170HM087CAG		1700	8.8	189	SP6C	
MSCSM170HM12CAG			11.7	142	SP6C	
MSCSM170HM23CT3AG			17.5	98	SP3F	
MSCSM170HM45CT3AG			35	51	SP3F	
MSCSM70AM025CD3AG	Phase Leg	700	2.5	538	D3	62EM1-00001
MSCSM70AM025CT6AG					SP6C	62EM1-00001
MSCSM70AM025CT6LIAG					SP6LI	
MSCSM70AM025D3AG				548	D3	62EM1-00001
MSCSM70AM025T6AG					SP6C	
MSCSM70AM025T6LIAG					SP6LI	
MSCSM70AM07CT3AG			5	276	SP3F	
MSCSM70AM07T3AG				281	SP3F	
MSCSM70AM10CT3AG			7.5	188	SP3F	
MSCSM70AM10T3AG				192	SP3F	
MSCSM70AM19CT1AG			15	97	SP1F	
MSCSM70AM19T1AG				98	SP1F	
MSCSM120AM02T6LIAG		1200	2.1	754	SP6LI	
MSCSM120AM02CT6LIAG					SP6LI	
MSCSM120AM03T6LIAG			2.5	640	SP6LI	
MSCSM120AM03CT6LIAG				641	SP6LI	
MSCSM120AM027CD3AG			2.7	584	D3	62EM1-00001
MSCSM120AM027CT6AG					SP6C	62EM1-00001
MSCSM120AM027D3AG			2.8	584	D3	
MSCSM120AM027T6AG					SP6C	
MSCSM120AM042CD3AG			4.2	394	D3	62EM1-00001



Part Number	Configuration	V _{DSS} (V)	R _{DS(ON)} (mΩ)	Current (A)	Package	Plug and Play Driver
MSCSM120AM042CT6AG	Phase Leg	1200	4.2	394	SP6C	62EM1-00001
MSCSM120AM042CT6LIAG					SP6LI	
MSCSM120AM042D3AG				395	D3	
MSCSM120AM042T6AG					SP6C	
MSCSM120AM042T6LIAG					SP6LI	
MSCSM120AM08CT3AG			6.25	268	SP3F	
MSCSM120AM08T3AG			6.3	268	SP3F	
MSCSM120AM11CT3AG			8.33	202	SP3F	62EM1-00001
MSCSM120AM11T3AG			8.4	202	SP3F	
MSCSM120AM16T1AG			12.5	138	SP1F	
MSCSM120AM16CT1AG					SP1F	
MSCSM120AM31T1AG			25	71	SP1F	
MSCSM120AM31CT1AG			25	71	SP1F	
MSCSM120AM50T1AG			40	44	SP1F	
MSCSM120AM50CT1AG					SP1F	
MSCSM170AM029CT6LIAG		1700	2.9	538	SP6LI	
MSCSM170AM039CD3AG			3.9	416	D3	62EM1-00001
MSCSM170AM039CT6AG					SP6C	62EM1-00001
MSCSM170AM058CD3AG			5.8	281	D3	62EM1-00001
MSCSM170AM058CT6AG					SP6C	62EM1-00001
MSCSM170AM058CT6LIAG					SP6LI	
MSCSM170AM11CT3AG				191	SP3F	
MSCSM170AM15CT3AG			11.7	144	SP3F	
MSCSM170AM23CT1AG			17.5	98	SP1F	
MSCSM170AM45CT1AG			35	51	SP1F	
MSCSM70TLM44C3AG	Three Level Inverter	700	35	46	SP3F	
MSCSM120TAM31CT3AG	Three Phase Bridge	1200	25	71	SP3F	
MSCSM70TAM05TPAG	Triple Phase Leg	700	5	273	SP6P	
MSCSM70TAM10CTPAG			7.5	186	SP6P	
MSCSM70TAM10TPAG				189	SP6P	
MSCSM70TAM19CT3AG			15	97	SP3F	
MSCSM70TAM19T3AG			15	98	SP3F	
MSCSM120TAM11CTPAG		1200	8.33	200	SP6P	
MSCSM120TAM11TPAG			8.4	200	SP6P	
MSCSM120TAM16TPAG			12.5	136	SP6P	
MSCSM120TAM16CTPAG					SP6P	
MSCSM120TAM31T3AG			25	71	SP3F	
MSCSM170TAM15CTPAG		1700	11.7	142	SP6P	
MSCSM170TAM23CTPAG			17.5	97	SP6P	
MSCSM170TAM45CT3AG			35	51	SP3F	

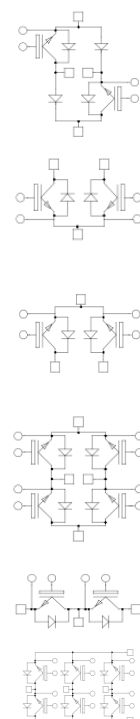


Part Number	Configuration	V _{DSS} (V)	R _{DS(ON)} (mΩ)	Current (A)	Package	Plug and Play Driver
MSCSM70VR1M10CTPAG	Triple Vienna Rectifier	700	7.5	189	SP6P	
MSCSM120VR1M16CTPAG		1200	12.5	136	SP6P	
MSCSM120HRM052NG	T-Type	1200	4.2	376	SP6C	
MSCSM120HRM08NG			6.3	252	SP6C	
MSCSM120HRM163AG			12.5	138	SP3F	
MSCSM120HRM311AG			25	71	SP1F	
MSCSM170HRM075NG		1700	5.8	268	SP6C	
MSCSM170HRM11NG			8.8	180	SP6C	
MSCSM170HRM233AG			17.5	98	SP3F	
MSCSM170HRM451AG			35	51	SP1F	
MSCSM70VM10C4AG	Vienna Phase Leg	700	7.5	97	SP4	
MSCSM70VM19C3AG			15	97	SP3F	
MSCSM70VR1M03CT6AG	Vienna Rectifier	700	3	465	SP6C	
MSCSM70VR1M07CT6AG			5	278	SP6C	
MSCSM70VR1M10CT3AG			7.5	192	SP3F	
MSCSM70VR1M19C1AG			15	98	SP1F	
MSCSM120VR1M062CT6AG		1200	5	334	SP6C	
MSCSM120VR1M11CT6AG			8.3	200	SP6C	
MSCSM120VR1M16CT3AG			12.5	138	SP3F	
MSCSM120VR1M31C1AG			25	71	SP1F	



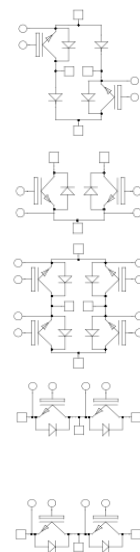
Baseplate-less mSiC™ MOSFET Modules

Part Number	Configuration	V _{DSS} (V)	R _{DS(ON)} (mΩ)	Current (A)	Package
MSCSM120DHM31CTBL2NG	Asymmetrical Bridge	1200	25	60	BL2
MSCSM120DAM31CTBL1NG	Boost Chopper	1200	25	60	BL1
MSCSM120SKM31CTBL1NG	Buck Chopper	1200	25	60	BL1
MSCSM120DDUM16TBL3NG	Double Dual Common Source	1200	12.5	120	BL3
MSCSM120DDUM31CTBL2NG			25	60	BL2
MSCSM120DDUM31TBL2NG				63	BL2
MSCSM120DDUM16CTBL3NG	Dual Common Source	1200	12.5	120	BL3
MSCSM120DUM31CTBL1NG			25	60	BL1
MSCSM120DUM31TBL1NG				63	BL1
MSCSM120HM16TBL3NG	Full Bridge	1200	12.5	120	BL3
MSCSM120HM16CTBL3NG					BL3
MSCSM120HM31CTBL2NG			25	60	BL2
MSCSM120HM31TBL2NG				63	BL2
MSCSM120AM31CTBL1NG	Phase Leg	1200	25	60	BL1
MSCSM120AM31TBL1NG				63	BL1
MSCSM120XM31RTBL3NG	Three Phase Bridge	1200	25	63	BL3



Baseplate-less Si IGBT Power Modules

Part Number	Silicon type	Configuration	V _{CE} (V)	V _{CE(sat)} (V)	Current (A) Tc=80 C	Package
MSCGLQ50DH120CTBL2NG	Trench 4 Fast	Asymmetrical bridge	1200	2.05	50	BL2
MSCGLQ50DU120CTBL1NG	Trench 4 Fast	Dual common source		2.05	50	BL1
MSCGLQ50DDU120CTBL2NG	Trench 4 Fast	Dual common source		2.05	50	BL2
MSCGLQ75DDU120CTBL3NG	Trench 4 Fast	Dual common source		2.05	75	BL3
MSCGLQ50H120CTBL2NG	Trench 4 Fast	Full bridge		2.05	50	BL2
MSCGLQ75H120CTBL3NG	Trench 4 Fast	Full bridge		2.05	75	BL3
MSCGLQ50A120CTBL1NG	Trench 4 Fast	Phase leg		2.05	50	BL1



Baseplate-less Si Diode Power Modules

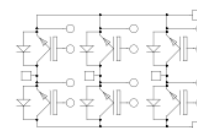
Part Number	Silicon Type	Configuration	V _{RRM} (V)	V _F (V)	Current (A) Tc=80 C	Package
MSCDR90A160BL1NG	Rectifier diode	Phase leg	1600	1.3	90	BL1



Standard Aerospace Power Modules

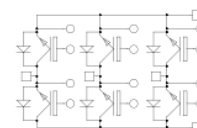
mSiC™ MOSFET Power Modules

Part Number	Type	Electrical Topology	Voltage	$R_{DS(on)}$ (mΩ)	Current (A) $T_c=80^{\circ}C$	Package
MSCSM70XM75CTYZBNMG	mSiC MOSFET Module	3 Phase Bridge + Actuation Full-Options	700	60	25	SP6HPD
MSCSM70XM45CTYZBNMG				35	45	SP6HPD
MSCSM70XM19CTYZBNMG				15	89	SP6HPD
MSCSM120X10CTYZBNMG			1200	80	22	SP6HPD
MSCSM120XM50CTYZBNMG				40	40	SP6HPD
MSCSM120XM31CTYZBNMG				25	64	SP6HPD



IGBT Power Modules with mSiC Diodes

Part Number	Type	Electrical Topology	Voltage	$V_{CE(sat)}$ (V)	Current (A) $T_c=80^{\circ}C$	Package
MSCGLQ50X065CTYZBNMG	Trench 4 Fast IGBT + SBD	3 Phase Bridge + Actuation Full-Options	650	1.85	50	SP6HPD
MSCGLQ75X065CTYZBNMG					75	SP6HPD
MSCGLQ100X065CTYZBNMG					100	SP6HPD
MSCGLQ40X120CTYZBNMG			1200	2.05	40	SP6HPD
MSCGLQ50X120CTYZBNMG					50	SP6HPD
MSCGLQ75X120CTYZBNMG					75	SP6HPD



IGBT & Si MOSFET Power Modules with mSiC™ Diodes

Boost Chopper

V _{RRM} (V)	IGBT Type	I _D (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
1200	Trench 4 Fast	25	2.05	SOT-227	No	APT25GLQ120JCU2
		40	2.05	SOT-227	No	APT40GLQ120JCU2

Dual Chopper

V _{RRM} (V)	IGBT Type	I _D (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
1200	Trench 4 Fast	40	2.05	SP3F	Yes	APTGLQ40DDA120CT3G

MOSFETs and Superjunction MOSFET Power Modules With mSiC Diodes

Single Switch + Series FRED and Parallel mSiC Diodes

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
1000	MOS 7	65	110	SP6	Option	APTM100UM65SCAVG
1200	MOS 7	100	86	SP6	Option	APTM120U10SCAVG

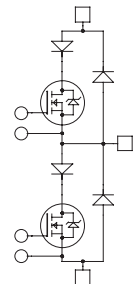
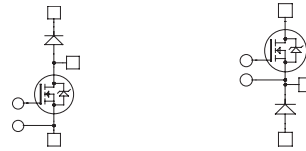
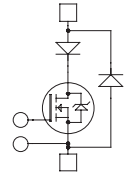
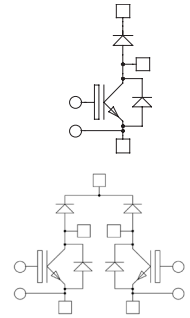
Power Modules With mSiC Diodes

Chopper

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	...DA... or ...U2	...SK... or ...U3
500	MOS 8	65	43	SOT-227	No	APT58M50JCU2	
600	Superjunction MOSFET	45	38	SOT-227	No	APT50N60JCCU2	
		24	70	SP1	Yes		APTC60SKM24CT1G
		18	107	SP4	Yes	APTC60DAM18CTG	
1000	MOS 8	330	20	SOT-227	No	APT26M100JCU2	APT26M100JCU3
1200	MOS 8	560	15	SOT-227	No	APT20M120JCU2	APT20M120JCU3
		300	23	SP1	Yes	APTM120DA30CT1G	

Phase Leg + Series FRED and Parallel mSiC Diodes

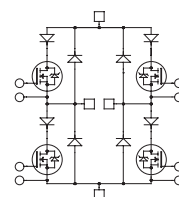
V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
500	MOS 7	38	67	SP4	Yes	APTM50AM38SCTG
		24	110	SP6C	No	APTM50AM24SCG
600	Superjunction MOSFET	35	54	SP4	Yes	APTC60AM35SCTG
		24	70	SP4	Yes	APTC60AM24SCTG
		18	107	SP6C	No	APTC60AM18SCG
		150	21	SP4	Yes	APTC80A15SCTG
800	Superjunction MOSFET	100	32	SP4	Yes	APTC80A10SCTG
		75	43	SP6C	No	APTC80AM75SCG
		130	49	SP6C	No	APTM100A13SCG





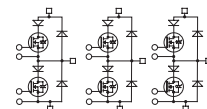
Full Bridge + Series FRED and Parallel mSiC Diodes

V_{DS} (V)	MOSFET Type	$R_{DS(on)}$ (m Ω)	I_D (A) $T_C = 80^\circ\text{C}$	Package	NTC	Part Number
500	MOS 7	75	34	SP4	Yes	APTM50HM75SCTG
600	Superjunction MOSFET	70	29	SP4	Yes	APTC60HM70SCTG
		45	38	SP4	Yes	APTC60HM45SCTG
800		290	11	SP4	Yes	APTC80H29SCTG
1000	MOS 7	450	14	SP4	Yes	APTM100H45SCTG

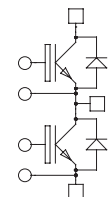
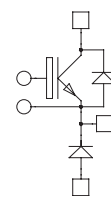
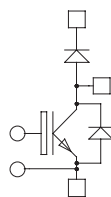


Triple Phase Leg

V_{DS} (V)	MOSFET Type	$R_{DS(on)}$ (m Ω)	I_D (A) $T_C = 80^\circ\text{C}$	Package	NTC	Part Number
600	Superjunction MOSFET	24	87	SP6-P	Yes	APTC60TAM21SCTPAG
1000	MOS 7	350	50	SP6-P	Yes	APTM100TA35SCTPG



IGBT Power Modules

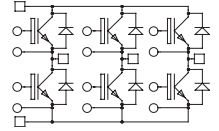


Chopper and Phase Leg

V _{(BR)CES} (V)	IGBT Type	I _C (A) T _c = 80°C	V _{CE(ON)} (V) at Rated I _C	Package	NTC	...DA... or ...U2	...SK... or ...U3	...A...
600	Trench 3	75	1.5	SP1	YES	APTGT75DA60T1G		APTGT75A60T1G
		100	1.5	SP1	YES	APTGT100DA60T1G		APTGT100A60T1G
		150	1.5	SP1	YES	APTGT150DA60T1G	APTGT150SK60T1G	APTGT150A60T1G
		150	1.5	SP3F	YES			APTGT150A60T3AG
		200	1.5	SP3F	YES	APTGT200DA60T3AG	APTGT200SK60T3AG	APTGT200A60T3AG
		300	1.5	SP4	YES			APTGT300A60TG
		300	1.5	SP6C	OPTION	APTGT300DA60G	APTGT300SK60G	APTGT300A60G
		300	1.5	D3	OPTION	APTGT300DA60D3G	APTGT300SK60D3G	APTGT300A60D3G
		400	1.5	D3	OPTION	APTGT400DA60D3G		APTGT400A60D3G
		450	1.5	SP6C	OPTION	APTGT450DA60G	APTGT450SK60G	APTGT450A60G
650	Trench 4 Fast	600	1.5	SP6C	OPTION	APTGT600DA60G	APTGT600SK60G	APTGT600A60G
		50	1.85	SOT227		APT50GLQ65JU2		
		50	1.85	SOT227		APT100GLQ65JU2	APT100GLQ65JU3	
	Trench 5	100	1.85	SP1	YES			APTGLQ100A65T1G
		600	1.85	SP6C	YES			APTGLQ600A65T6G
		60	1.65	SP1	YES	APTGTQ100DA65T1G	APTGTQ100SK65T1G	APTGTQ100A65T1G
1200	Trench 3	120	1.65	SP3F	YES	APTGTQ200DA65T3G	APTGTQ200SK65T3G	APTGTQ200A65T3G
		35	1.7	SP1	YES			APTGT35A120T1G
		35	1.7	SOT227	-	APT35GT120JU2	APT35GT120JU3	
		50	1.7	SOT227	-	APT50GT120JU2	APT50GT120JU3	
		50	1.7	SP1	YES			APTGT50A120T1G
		50	1.7	SP4	YES	APTGT50DA120TG	APTGT50SK120TG	
		75	1.7	SOT227	-	APT75GT120JU2	APT75GT120JU3	
		75	1.7	SP1	YES			APTGT75A120T1G
		75	1.7	SP4	YES	APTGT75DA120TG	APTGT75SK120TG	
		100	1.7	SP1	YES	APTGT100DA120T1G		
		100	1.7	SOT227	-	APT100GT120JU2	APT100GT120JU3	
		100	1.7	SP3F	YES			APTGT100A120T3AG
		100	1.7	SP4	YES			APTGT100A120TG
		150	1.7	SP6C	OPTION	APTGT150DA120G	APTGT150SK120G	APTGT150A120G
		150	1.7	SP3F	YES			APTGT150A120T3AG
		150	1.7	SP4	YES			APTGT150A120TG
		200	1.7	SP6C	OPTION	APTGT200DA120G	APTGT200SK120G	APTGT200A120G
		200	1.7	D3	OPTION	APTGT200DA120D3G		APTGT200A120D3G
	Trench 4	300	1.7	SP6C	OPTION	APTGT300DA120G	APTGT300SK120G	APTGT300A120G
		300	1.7	D3	OPTION			APTGT300A120D3G
		400	1.7	SP6C	OPTION	APTGT400DA120G	APTGT400SK120G	APTGT400A120G
		400	1.7	D3	OPTION			APTGT400A120D3G
		40	1.85	SOT227	-	APT40GL120JU2	APT40GL120JU3	
		90	1.85	SP1	YES	APTGL90DA120T1G		APTGL90A120T1G
	Trench 4 Fast	180	1.85	SP3F	YES			APTGL180A120T3AG
		325	1.85	D3	OPTION			APTGL325A120D3G
		475	1.85	D3	OPTION	APTGL475DA120D3G	APTGL475SK120D3G	APTGL475A120D3G
		700	1.85	D3	OPTION	APTGL700DA120D3G	APTGL700SK120D3G	
		100	2.05	SP3F	YES			APTGLQ100A120T3AG
		100	2.05	SP1	YES	APTGLQ100DA120T1G		
1700	Trench 3	100	2.05	SP4	YES			APTGLQ100A120TG
		150	2.05	SP4	YES			APTGLQ150A120TG
		200	2.05	SP3F	YES			APTGLQ200A120T3AG
		300	2.05	SP6C			APTGLQ300SK120G	APTGLQ300A120G
		400	2.05	SP6C	YES			APTGLQ400A120T6G
		30	2	SP1	YES			APTGT30A170T1G
		50	2	SP1	YES		APTGT50SK170T1G	APTGT50A170T1G
		50	2	SP4	YES		APTGT50SK170TG	APTGT50A170TG
		100	2	SP4	YES		APTGT100SK170TG	APTGT100A170TG
		150	2	SP6C	OPTION		APTGT150SK170G	
		200	2	D3	OPTION			APTGT200A170D3G
		225	2	SP6C	OPTION		APTGT225SK170G	APTGT225A170G
		300	2	SP6C	OPTION	APTGT300DA170G	APTGT300SK170G	APTGT300A170G
		300	2	D3	OPTION	APTGT300DA170D3G		APTGT300A170D3G

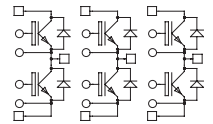
Three-Phase Bridge

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) $T_C = 80^\circ\text{C}$	$V_{CE(ON)}$ (V) at Rated I_C	Package	NTC	Part Number
600	Trench 3	30	1.5	SP3F	Yes	APTGT30X60T3G
		50	1.5	SP3F	Yes	APTGT50X60T3G
		75	1.5	SP3F	Yes	APTGT75X60T3G
1200	Trench 3	25	1.7	SP3F	Yes	APTGT25X120T3G
		35	1.7	SP3F	Yes	APTGT35X120T3G
	Trench 4	40	1.85	SP3F	Yes	MSCGL40X120T3AG
		40	1.85	SP3F	Yes	APTGL40X120T3G



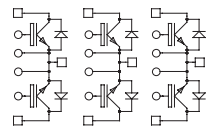
Triple Phase Leg

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) $T_C = 80^\circ\text{C}$	$V_{CE(ON)}$ (V) at Rated I_C	Package	NTC	Part Number
600	Trench 3	50	1.5	SP6-P	Option	APTGT50TA60PG
		150	1.5	SP6-P	Option	APTGT150TA60PG
650	Trench 5	30	1.65	SP3F	Yes	APTGTQ50TA65T3G
		90	1.65	SP6-P	Yes	APTGTQ150TA65TPG
1200	Trench 3	75	1.7	SP6-P	Option	APTGT75TA120PG
		100	1.7	SP6-P	Yes	APTGT100TA120TPG
	Trench 4	120	1.85	SP6-P	Yes	APTGL120TA120TPG



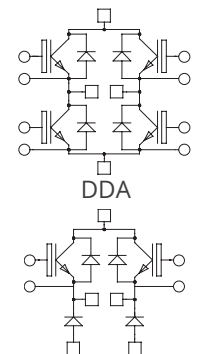
Triple Dual Common Source

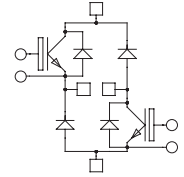
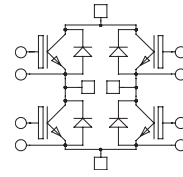
$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) $T_C = 80^\circ\text{C}$	$V_{CE(ON)}$ (V) at Rated I_C	Package	NTC	Part Number
600	Trench 3	50	1.5	SP6-P	Option	APTGT50TDU60PG
		75	1.5	SP6-P	Option	APTGT75TDU60PG
		100	1.5	SP6-P	Option	APTGT100TDU60PG
		150	1.5	SP6-P	Option	APTGT150TDU60PG
1200	Trench 3	75	1.7	SP6-P	Option	APTGT75TDU120PG
	Trench 4	120	1.85	SP6-P	Yes	APTGL120TDU120TPG
1700	Trench 3	50	2	SP6-P	Option	APTGT50TDU170PG



Dual Chopper

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) $T_C = 80^\circ\text{C}$	$V_{CE(ON)}$ (V) at Rated I_C	Package	NTC	...DDA...	...DSK...
600	Trench 3	50	1.5	SP3F	Yes	APTGT50DDA60T3G	
		75	1.5	SP3F	Yes	APTGT75DDA60T3G	
650	Trench 5	60	1.65	SP3F	Yes	APTGTQ100DDA65T3G	
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50DDA65T3G	
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50VDA65T3G	
1200	Trench 3	50	1.7	SP3F	Yes	APTGT50DDA120T3G	
	Trench 4	60	1.85	SP3F	Yes	APTGL60DDA120T3G	
		90	1.85	SP3F	Yes	APTGL90DDA120T3G	APTGL90DSK120T3G



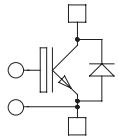


Full and Asymmetrical

$V_{(BR)CES}$ (V)	IGBT Type	I_C (A) $T_c = 80^\circ\text{C}$	$V_{CE(ON)}$ (V) at Rated I_C	Package	NTC	...H...	...DH...
600	Trench 3	20	1.5	SP1	YES	APTGT20H60T1G	
		30	1.5	SP1	YES	APTGT30H60T1G	
		50	1.5	SP1	YES	APTGT50H60T1G	APTGT50DH60T1G
		50	1.5	SP3F	YES	APTGT50H60T3G	
		75	1.5	SP1	YES	APTGT75H60T1G	
		75	1.5	SP3F	YES	APTGT75H60T3G	
		100	1.5	SP4	YES	APTGT100H60TG	APTGT100DH60TG
		100	1.5	SP3F	YES	APTGT100H60T3G	
		150	1.5	SP4	YES	APTGT150H60TG	APTGT150DH60TG
		200	1.5	SP6C		APTGT200H60G	APTGT200DH60G
		300	1.5	SP6C		APTGT300H60G	APTGT300DH60G
650	Trench 4 Fast	30	1.95	SP3F	YES	APTGLQ30H65T3G	
		50	1.85	SP1	YES	APTGLQ50H65T1G	
		50	1.85	SP3F	YES	APTGLQ50H65T3G	
		75	1.85	SP1	YES	APTGLQ75H65T1G	
		100	1.85	SP3F	YES	APTGLQ100H65T3G	
		200	1.85	SP6C		APTGLQ200H65G	
		300	1.85	SP6C	OPTION	APTGLQ300H65G	
	Trench 5	60	1.65	SP3F	YES	APTGTQ100H65T3G	
1200	Trench 3	35	1.7	SP3F	YES	APTGT35H120T3G	
		50	1.7	SP3F	YES	APTGT50H120T3G	
		50	1.7	SP4	YES		APTGT50DH120TG
		75	1.7	SP3F	YES		APTGT75DH120T3G
		75	1.7	SP4	YES	APTGT75H120TG	
		100	1.7	SP4	YES		APTGT100DH120TG
		100	1.7	SP6C		APTGT100H120G	
		150	1.7	SP6C		APTGT150H120G	APTGT150DH120G
		200	1.7	SP6C		APTGT200H120G	APTGT200DH120G
	Trench 4	40	1.85	SP1	YES	APTGL40H120T1G	
		60	1.85	SP3F	YES	APTGL60H120T3G	
		90	1.85	SP3F	YES	APTGL90H120T3G	
	Trench 4 Fast	25	2.05	SP1	YES	APTGLQ25H120T1G	
		40	2.05	SP1	YES	APTGLQ40H120T1G	
		75	2.05	SP3F	YES	APTGLQ75H120T3G	
		75	2.05	SP4	YES	APTGLQ75H120TG	
		150	2.05	SP6C		APTGLQ150H120G	
		200	2.05	SP6C	OPTION	APTGLQ200H120G	
1700	Trench 3	30	2	SP3F	YES	APTGT30H170T3G	
		50	2	SP4	YES	APTGT50H170TG	APTGT50DH170TG
		100	2	SP6C		APTGT100H170G	
		150	2	SP6C			APTGT150DH170G

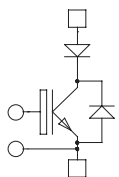
Single Switch

V _{CES} (V)	IGBT Type	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Trench 3	750	1.5	D4	No	APTGT750U60D4G
1200	Trench 3	400	1.7	D4	No	APTGT400U120D4G
		600	1.7	D4	No	APTGT600U120D4G
	Trench 4	475	1.85	D4	No	APTGL475U120D4G
		700	1.85	D4	No	APTGL700U120D4G
1700	Trench 3	400	2	D4	No	APTGT400U170D4G
		600	2	D4	No	APTGT600U170D4G



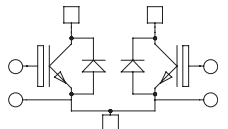
Single Switch + Series Diode

V _{CES} (V)	IGBT Type	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
1200	Trench 4	475	1.85	SP6C	No	APTGL475U120DAG



Dual Common Source

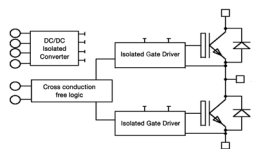
V _{CES} (V)	IGBT Type	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Trench 3	100	1.5	SP4	Yes	APTGT100DU60TG
		200	1.5	SP4	Yes	APTGT200DU60TG
		300	1.4	SP6C	No	APTGT300DU60G
		600	1.4	SP6C	No	APTGT600DU60G
1200	Trench 3	50	1.7	SP4	Yes	APTGT50DU120TG
		75	1.7	SP4	Yes	APTGT75DU120TG
		100	1.7	SP4	Yes	APTGT100DU120TG
		150	1.7	SP6C	No	APTGT150DU120G
		150	1.7	SP4	Yes	APTGT150DU120TG
		200	1.7	SP6C	No	APTGT200DU120G
		300	1.7	SP6C	No	APTGT300DU120G
		400	1.7	SP6C	No	APTGT400DU120G
1700	Trench 3	100	2	SP4	Yes	APTGT100DU170TG
		225	2	SP6C	No	APTGT225DU170G
		300	2	SP6C	No	APTGT300DU170G



Intelligent Power Modules

Phase Leg

V _{CES} (V)	IGBT Type	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Trench 3	400	1.5	LP8	No	APTLGT400A608G
1200	Trench 3	300	1.7	LP8	No	APTLGT300A1208G
	Trench 4	325	1.8	LP8	No	APTLGL325A1208G

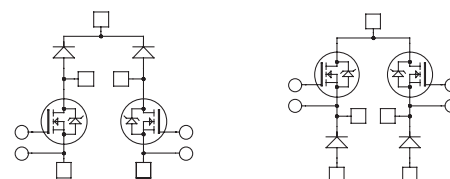


MOSFET Power Modules



Chopper

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	DA...or...U2	SK...or...U3
100	MOS 5	11	100	SOT-227	No	APT10M11JVRU2	APT10M11JVRU3
		4.5	207	SP4	Yes	APTM10DAM05TG	APTM10SKM05TG
		2.25	370	SP6C	No	APTM10DAM02G	APTM10SKM02G
200	MOS 5	22	71	SOT-227	No	APT20M22JVRU2	APT20M22JVRU3
	MOS™ 7	8	147	SP4	Yes	APTM20DAM08TG	APTM20SKM08TG
		5	250	SP6C	Option	APTM20DAM05G	
		4	300	SP6C	Option	APTM20DAM04G	APTM20SKM04G
500	MOS 5	100	30	SOT-227	No	APT5010JVRU2	APT5010JVRU3
	MOS 7	100	30	SOT-227	No	APT5010JLLU2	APT5010JLLU3
		75	32	SOT-227	No	APT50M75JLLU2	APT50M75JLLU3
		19	125	SP6C	Option	APTM50DAM19G	APTM50SKM19G
		17	140	SP6C	Option	APTM50DAM17G	APTM50SKM17G
	MOS 8	65	43	SOT-227	No	APT58M50JU2	APT58M50JU3
600	Superjunction MOSFET	70	40	SOT-227	No	APT40N60JCU2	APT40N60JCU3
		24	70	SP1	Yes		APTC60SKM24T1G
1000	MOS 7	180	33	SP4	Yes	APTM100DA18TG	
		90	59	SP6C	Option	APTM100DAM90G	
	MOS 8	330	17	SP1	Yes		APTM100SK33T1G
1200	MOS 8	300	23	SP1	Yes	APTM120DA30T1G	

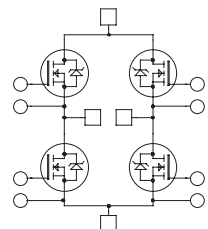


Dual Chopper

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	...DDA...	...DSK...
100	MOS 5	19	50	SP3F	Yes		APTM10DSKM19T3G
		9	100	SP3F	Yes		APTM10DSKM09T3G
500	MOS 7	100	24	SP3F	Yes	APTM50DDA10T3G	
		65	37	SP3F	Yes	APTM50DDAM65T3G	
600	Superjunction MOSFET	45	38	SP1	Yes	APTC60DDAM45T1G	
		70	29	SP1	Yes	APTC60DDAM70T1G	
		35	54	SP3F	Yes	APTC60DDAM35T3G	
		24	70	SP3F	Yes	APTC60DDAM24T3G	APTC60DSKM24T3G
		150	21	SP3F	Yes	APTC80DDA15T3G	
800							
1000	MOS 7	350	17	SP3F	Yes		APTM100DSK35T3G

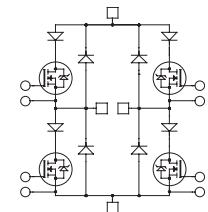
Full Bridge

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
100	FREDFET 5	4.5	207	SP6C	No	APTM10HM05FG
		19	50	SP3F	Yes	APTM10HM19FT3G
		9	100	SP3F	Yes	APTM10HM09FT3G
200	FREDFET 7	20	62	SP4	Yes	APTM20HM20FTG
		16	74	SP4	Yes	APTM20HM16FTG
		10	125	SP6C	No	APTM20HM10FG
		8	147	SP6C	No	APTM20HM08FG
500	FREDFET 7	140	18	SP3F	Yes	APTM50H14FT3G
		100	24	SP3F	Yes	APTM50H10FT3G
		75	32	SP4	Yes	APTM50HM75FTG
		75	32	SP3F	Yes	APTM50HM75FT3G
		65	37	SP4	Yes	APTM50HM65FTG
		65	37	SP3F	Yes	APTM50HM65FT3G
		38	64	SP6C	No	APTM50HM38FG
		35	70	SP6C	No	APTM50HM35FG
600	FREDFET 8	150	19	SP1	Yes	APTM50H15FT1G
	Superjunction MOSFET	70	29	SP1	Yes	APTC60HM70T1G
		45	38	SP1	Yes	APTC60HM45T1G
		70	29	SP3F	Yes	APTC60HM70T3G
		35	54	SP3F	Yes	APTC60HM35T3G
		24	70	SP3F	Yes	APTC60HM24T3G
		230	15	SP1	Yes	APTM60H23FT1G
800	Superjunction MOSFET	150	21	SP1	Yes	APTC80H15T1G
		290	11	SP3F	Yes	APTC80H29T3G
		150	21	SP3F	Yes	APTC80H15T3G
1000	FREDFET 7	450	14	SP3F	Yes	APTM100H45FT3G
		350	17	SP4	Yes	APTM100H35FTG
		350	17	SP3F	Yes	APTM100H35FT3G
	FREDFET 8	180	33	SP6C	No	APTM100H18FG
		460	14	SP3F	Yes	APTM100H46FT3G
1200	FREDFET 7	290	25	SP6C	No	APTM120H29FG
	FREDFET 8	1400	6	SP1	Yes	APTM120H140FT1G



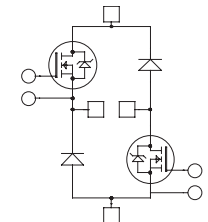
Full Bridge + Series and Parallel

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
200	MOS 7™	20	62	SP4	Yes	APTM20HM20STG
500	MOS 7	75	32	SP4	Yes	APTM50HM75STG
1000	MOS 7	450	13	SP4	Yes	APTM100H45STG



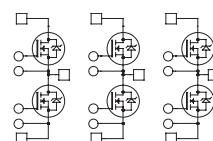
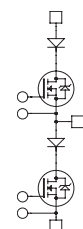
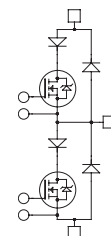
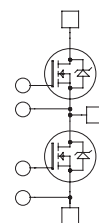
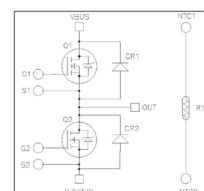
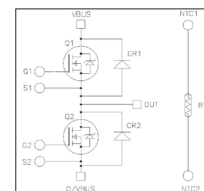
Asymmetrical Bridge

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
100	MOS 5	4.5	207	SP6C	No	APTM10DHM05G
500	MOS 7	38	64	SP6C	No	APTM50DHM38G
600	Superjunction MOSFET	24	70	SP3F	Yes	APTC60DHM24T3G



Phase Leg

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
100	FREDFET 5	4.5	207	SP4	Yes	APTM10AM05FTG
		2.25	370	SP6C	Option	APTM10AM02FG
200	FREDFET 7	10	125	SP4	Yes	APTM20AM10FTG
		8	147	SP4	Yes	APTM20AM08FTG
		5	250	SP6C	Option	APTM20AM05FG
		5	280	LP8		MSCM20AM058G
		4	300	SP6C	Option	APTM20AM04FG
500	FREDFET 7	38	64	SP4	Yes	APTM50AM38FTG
		35	70	SP4	Yes	APTM50AM35FTG
		19	125	SP6C	Option	APTM50AM19FG
		17	140	SP6C	Option	APTM50AM17FG
600	Superjunction MOSFET	45	38	SP1	Yes	APTC60AM45T1G
		35	54	SP1	Yes	APTC60AM35T1G
		24	70	SP1	Yes	APTC60AM24T1G
	FREDFET 8	110	30	SP1	Yes	APTM60A11FT1G
1000	FREDFET 7	180	33	SP4	Yes	APTM100A18FTG
		90	59	SP6C	Option	APTM100AM90FG
1200	FREDFET 7	290	25	SP4	Yes	APTM120A29FTG
		150	45	SP6C	Option	APTM120A15FG



Phase Leg + Series and Parallel

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
200	MOS 7™	10	125	SP4	Yes	APTM20AM10STG
		6	225	SP6C	No	APTM20AM06SG
500	MOS 7	38	64	SP4	Yes	APTM50AM38STG
		24	110	SP6C	No	APTM50AM24SG
1000	MOS 7	230	26	SP4	Yes	APTM100A23STG
		130	49	SP6C	No	APTM100A13SG
1200	MOS 7	200	37	SP6C	No	APTM120A20SG

Phase Leg + Series Diodes

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
1000	MOS 7	130	49	SP6C	No	APTM100A13DG
1200	MOS 7	200	37	SP6C	No	APTM120A20DG

Triple Phase Leg

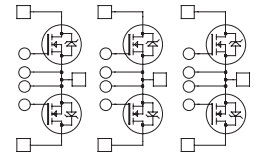
V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
75	MOSFET	4.2	90	SP6-P	Option	APTM08TAM04PG
100	FREDFET 5	19	50	SP6-P	Option	APTM10TAM19FPG
		9	100	SP6-P	Option	APTM10TAM09FPG
200	FREDFET 7	16	74	SP6-P	Option	APTM20TAM16FPG
500	FREDFET 7	65	37	SP6-P	Option	APTM50TAM65FPG
600	Superjunction MOSFET	35	54	SP6-P	Option	APTC60TAM35PG
		24	70	SP6-P	Yes	APTC60TAM24TPG
1000	FREDFET 7	350	17	SP6-P	Option	APTM100TA35FPG

Three-Phase Bridge

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
200	FREDFET 5	16	77	SP4		MSCM20XM16F4G
	FREDFET 5	10	84	SP3X		MSCM20XM10T3XG

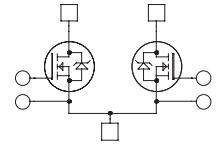
Triple Dual Common Source

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
600	Superjunction	35	54	SP6-P	Option	APTC60TDUM35PG
800	MOSFET	150	21	SP6-P	Option	APTC80TDU15PG



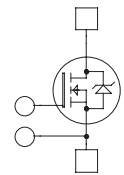
Dual Common Source

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
100	MOS 5	2.25	370	SP6C	No	APTM10DUM02G
200	MOS 7™	8	147	SP4	Yes	APTM20DUM08TG
		5	250	SP6C	No	APTM20DUM05G
		4	300	SP6C	No	APTM20DUM04G
1200	MOS 7	150	45	SP6C	No	APTM120DU15G



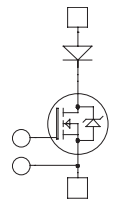
Single Switch

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
100	FREDFET 5	2.25	430	SP6C	Option	APTM10UM02FAG
		1.5	640	SP6C	Option	APTM10UM01FAG
200	FREDFET 7	3	434	SP6C	Option	APTM20UM03FAG
500	FREDFET 7	9	371	SP6C	Option	APTM50UM09FAG
1000	FREDFET 7	60	97	SP6C	Option	APTM100UM60FAG
		45	160	SP6C	Option	APTM100UM45FAG
1200	FREDFET 7	70	126	SP6C	Option	APTM120UM70FAG



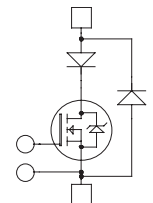
Single Switch + Series Diode

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
1000	MOS 7	65	110	SP6C	No	APTM100UM65DAG
		45	160	SP6C	No	APTM100UM45DAG
1200	MOS 7	70	126	SP6C	No	APTM120UM70DAG



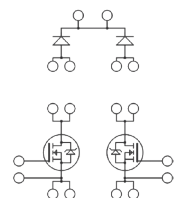
Single Switch + Series and Parallel

V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
200	MOS 7	4	310	SP6C	Option	APTM20UM04SAG
500	MOS 7	13	250	SP6C	Option	APTM50UM13SAG
1000	MOS 7	65	110	SP6C	Option	APTM100UM65SAG
1200	MOS 7	100	86	SP6C	Option	APTM120U10SAG



Interleaved PFC

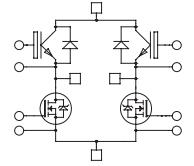
V _{DSS} (V)	MOSFET Type	R _{DS(on)} (mΩ)	I _D (A) T _C = 80°C	Package	NTC	Part Number
600	Superjunction MOSFET	45	38	SP1	Yes	APTC60VDAM45T1G
		24	70	SP3F	Yes	APTC60VDAM24T3G



Renewable Energy Power Module

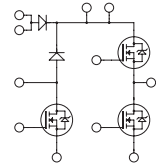
Full Bridge

V _{CEs} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Mix Trench IGBT & Superjunction MOSFET	50	83 mΩ/1.5	SP1	Yes	APTCV40H60CT1G
		50	45 mΩ/1.5	SP3F	Yes	APTCV50H60T3G



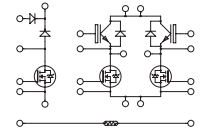
PFC + Bypass Diode + Phase Leg

V _{CEs} (V)	Technology	I _D (A) T _C = 80°C	R _{DS(on)} (mΩ) at Rated I _D	Package	NTC	Special	Part Number
600	Superjunction MOSFET	38	45	SP1	N/A	10A PFC mSiC Diode	APTC60AM45BC1G
		38	45	SP1	N/A		APTC60AM45B1G



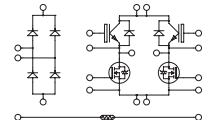
PFC + Bypass Diode + Full Bridge

V _{CEs} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Special	Part Number
600	Mix Trench IGBT & Superjunction MOSFET	38	45 mΩ/1.5	SP3F	Yes	20A PFC mSiC Diode	APTCV60HM45BC20T3G
		38	45 mΩ/1.5	SP3F	Yes		APTCV60HM45BT3G
	Superjunction MOSFET	29	70 mΩ	SP3F	Yes		APTC60HM70BT3G



Secondary Fast Rectifier + Full Bridge

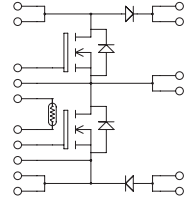
V _{CEs} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Special	Part Number
600	Mix Trench IGBT & Superjunction MOSFET	38	45 mΩ/1.5	SP3F	Yes	20A SiC Antiparallel Diode	APTCV60HM45RCT3G
		38	45 mΩ/1.5	SP3F	Yes		APTCV60HM45RT3G
	Superjunction MOSFET	29	70 mΩ	SP3F	Yes		APTC60HM70RT3G
	Trench 3	50	1.5	SP3F	Yes		APTGT50H60RT3G



R_{DS(on)} value for the MOSFETs in mΩ and V_{CE(on)} value for the IGBTs in Volts

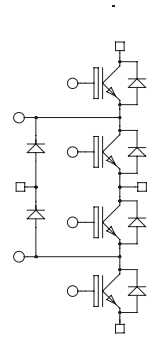
Boost Buck

V _{CES} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Superjunction MOSFET Trench 3	70	24 mΩ	SP3F	Yes	APTC60BBM24T3G
		100	1.5	SP3F	Yes	APTGT100BB60T3G

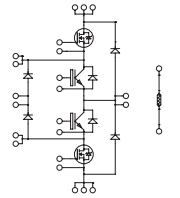


Three-Level NPC Inverter

V _{CES} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Trench 3	20	1.5	SP1	No	APTGT20TL601G
		30	1.5	SP1	No	APTGT30TL601G
		50	1.5	SP3F	Yes	APTGT50TL60T3G
		50	1.5	SP1	No	APTGT50TL601G
		75	1.5	SP3F	Yes	APTGT75TL60T3G
		100	1.5	SP3F	Yes	APTGT100TL60T3G
		150	1.5	SP6C	No	APTGT150TL60G
		200	1.5	SP6C	No	APTGT200TL60G
		300	1.5	SP6C	No	APTGT300TL60G
650	Trench 3	300	1.5	SP6C	No	APTGT300TL65G
		400	1.5	SP6C	No	APTGT400TL65G
	Trench 4 Fast	50	1.85	SP3F	Yes	APTGLQ50TL65T3G
1200	Trench 4	60	1.85	SP3F	Yes	APTGL60TL120T3G
		240	1.8	SP6C	No	APTGL240TL120G
1700	Trench 3	100	2	SP6C	No	APTGT100TL170G

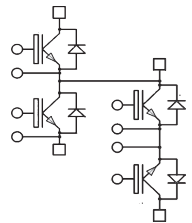


V _{CES} (V)	Technology	R _{DS(on)} Superjunction MOSFET (mΩ)	V _{CE (ON)} IGBT (V)/ I _C (A)	Package	NTC	Part Number
600	Mix Trench IGBT and Superjunction MOSFET	24	1.5/75	SP3F	Yes	APTCV60TLM24T3G
		45	1.5/75	SP3F	Yes	APTCV60TLM45T3G
		70	1.5/50	SP3F	Yes	APTCV60TLM70T3G
		99	1.5/30	SP3F	Yes	APTCV60TLM99T3G



T-Type 3-Level Inverter

V _{CES} (V)	Technology	I _C (A) T _C = 80°C	V _{CE (ON)} (V) at Rated I _C	Package	NTC	Special	Part Number
600/1200	Trench 4 Fast	40	2.05	SP3F	Yes	10A/600V mSiC Diode	APTGLQ40HR120CT3G
		80	2.05	SP3F	Yes	30A/600V mSiC Diode	APTGLQ80HR120CT3G
		200	2.05	SP6	No		APTGLQ200HR120G



Vienna Rectifier

V _{CES} (V)	IGBT Type	I _C (A) T _C = 80°C	V _{CE(ON)} (V) at Rated I _C	Package	NTC	Part Number
600	Superjunction MOSFET	19	99 mΩ	SP3F	YES	MSCC60VRM99CT3AG
		40	45 mΩ	SP6-P	YES	MSCC60VRM45TAPG
		81	23 mΩ	SP4		MSCC60AM23C4AG
650	Trench 5	80	1.65	SP1		MSCGTQ100HD65C1AG

R_{DS(on)} value for the MOSFETs in mΩ and V_{CE(on)} value for the IGBTs in Volts

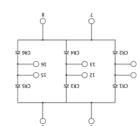
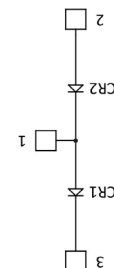
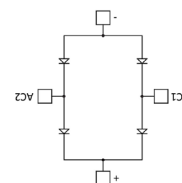
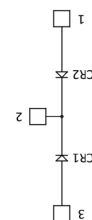
mSiC™ Diode Modules

Power Module Advantages

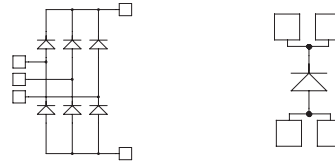
- High-speed switching
- Low switching losses
- Low-input capacitance
- High-power density
- Low-profile packages
- Minimum parasitic inductance
- Lower system cost
- Standard and custom modules
- 30+ years design experience

mSiC Diode Modules

Part Number	Configuration	Voltage (V)	Current (A)	VF (V)	Package
MSCDC100KK70D1PAG	Dual Common Cathode	700	100	1.5	D1P
MSCDC150KK70D1PAG			150	1.5	D1P
MSCDC200KK70D1PAG			200	1.5	D1P
MSCDC100KK120D1PAG		1200	100	1.5	D1P
MSCDC150KK120D1PAG			150	1.5	D1P
MSCDC200KK120D1PAG			200	1.5	D1P
MSCDC100KK170D1PAG		1700	100	1.5	D1P
MSCDC150KK170D1PAG			150	1.5	D1P
MSCDC200KK170D1PAG			200	1.5	D1P
MSC50DC70HJ	Full Bridge	700	50	1.5	SOT-227
MSCDC50H701AG				1.5	SP1F
MSCDC100H70AG			100	1.5	SP6C
MSCDC200H70AG			200	1.5	SP6C
MSC50DC120HJ		1200	50	1.5	SOT-227
MSCDC50H1201AG				1.5	SP1F
MSCDC100H120AG			100	1.5	SP6C
MSCDC200H120AG			200	1.5	SP6C
MSC50DC170HJ		1700	50	1.5	SOT-227
MSCDC50H1701AG				1.5	SP1F
MSCDC100H170AG			100	1.5	SP6C
MSCDC200H170AG			200	1.5	SP6C
MSCDC100A70D1PAG	Phase Leg	700	100	1.5	D1P
MSCDC150A70D1PAG			150	1.5	D1P
MSCDC200A70D1PAG			200	1.5	D1P
MSCDC300A70AG			300	1.5	SP6C
MSCDC450A70AG			450	1.5	SP6C
MSCDC600A70AG			600	1.5	SP6C
MSCDC100A120D1PAG		1200	100	1.5	D1P
MSCDC150A120D1PAG			150	1.5	D1P
MSCDC200A120D1PAG			200	1.5	D1P
MSCDC300A120AG			300	1.5	SP6C
MSCDC450A120AG			450	1.5	SP6C
MSCDC600A120AG			600	1.5	SP6C
MSCDC100A170D1PAG		1700	100	1.5	D1P
MSCDC150A170D1PAG			150	1.5	D1P
MSCDC200A170D1PAG			200	1.5	D1P
MSCDC300A170AG			300	1.5	SP6C
MSCDC450A170AG			450	1.5	SP6C
MSCDC600A170AG			600	1.5	SP6C
MSCDC50X701AG	Three Phase Bridge	700	50	1.5	SP1F
MSCDC50X1201AG		1200	50	1.5	SP1F
MSCDC50X1701AG		1700	50	1.5	SP1F



Diode Power Modules

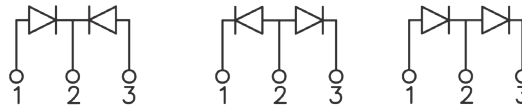


V_{RRM} (V)	Diode Type	I_F (A) $T_c = 80^\circ\text{C}$	V_F (V) $T_c = 80^\circ\text{C}$	Package	Part Number
200	FRED	500	1.1	LP4	APTDF500U20G
400		500	1.5		APTDF500U40G
600		450	1.8		APTDF450U60G
1000		430	2.3		APTDF430U100G
1200		400	2.5		APTDF400U120G

Single Diode

V_{RRM} (V)	Diode Type	I_F (A) $T_c = 80^\circ\text{C}$	V_F (V) $T_J = 25^\circ\text{C}$	Package	Part Number
1600	Rectifier	40	1.3	SP1	APTDR40X1601G
		90	1.3	SP1	APTDR90X1601G

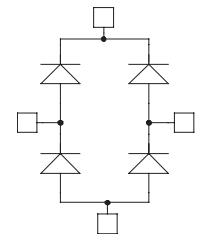
Common Cathode– Common Anode–Doubler



V_{RRM} (V)	Diode Type	I_F (A) per Diode	V_F (V) $T_J = 25^\circ\text{C}$	Package	Common Cathode	Common Anode	Doubler
200	FRED	400	1	SP6C	APTDF400KK20G	APTDF400AA20G	APTDF400AK20G
600			1.6		APTDF400KK60G	APTDF400AA60G	APTDF400AK60G
1000			2.1		APTDF400KK100G	APTDF400AA100G	APTDF400AK100G
1200			2.4		APTDF400KK120G	APTDF400AA120G	APTDF400AK120G
1700			2.2		APTDF400KK170G	APTDF400AA170G	APTDF400AK170G

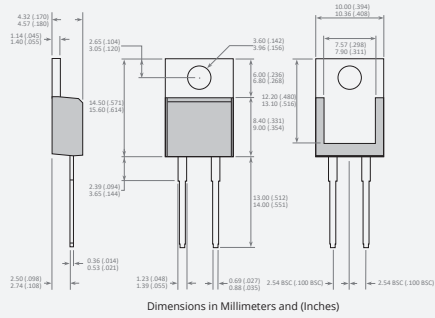
Full Bridge

V _{RRM} (V)	Diode Type	I _F (A) T _c = 80°C	V _F (V) T _c = 80°C	Package	Part Number
200	FRED	30	1	SOT-227	APT30DF20HJ
		60	1	SOT-227	APT60DF20HJ
		100	1	SP4	APTDF100H20G
30		1.8	SP1	APTDF30H601G	
30		1.8	SOT-227	APT30DF60HJ	
60		1.8	SOT-227	APT60DF60HJ	
60		1.8	SP1	APTDF60H601G	
100		1.6	SOT-227	APT100DL60HJ	
100		1.6	SP1	APTDF100H601G	
200		1.6	SP6	APTDF200H60G	
1000		30	2.1	SOT-227	APT30DF100HJ
		100	2.1	SP4	APTDF100H100G
		200	2.1	SP6C	APTDF200H100G
1200		30	2.6	SP1	APTDF30H1201G
		60	2.6	SP1	APTDF60H1201G
		75	1.6	SOT-227	APT75DL120HJ
		200	2.4	SP6C	APTDF200H120G
1700		50	1.8	SOT-227	APT50DF170HJ
		75	1.8	SOT-227	APT75DF170HJ
1600	RECTIFIER	40	1.3	SOT-227	APT40DR160HJ
		90	1.3	SOT-227	APT90DR160HJ

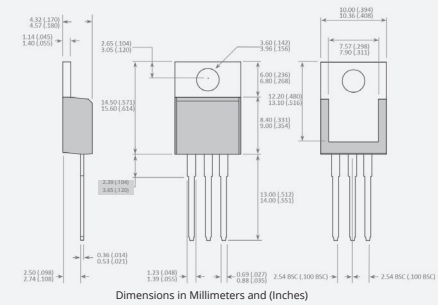


Power Discrete and Module Outlines

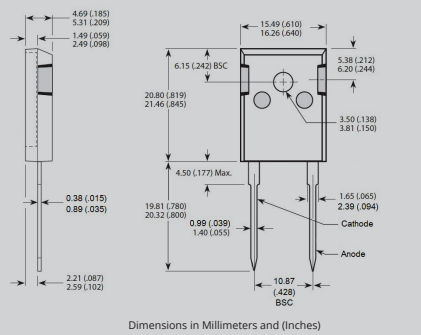
TO-220 2-Lead



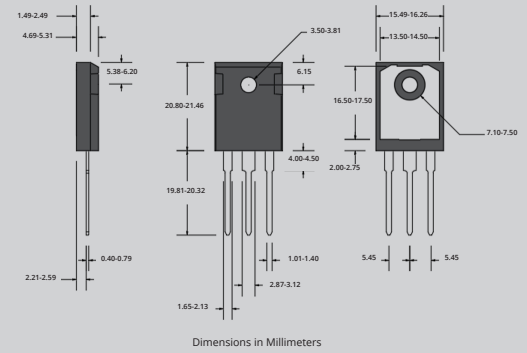
TO-220 3-Lead



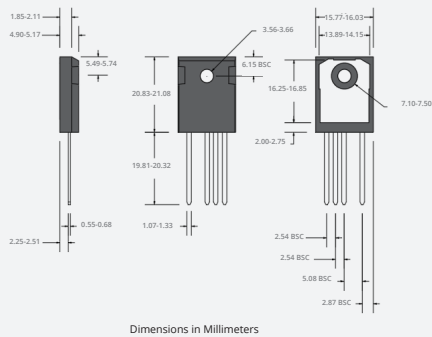
TO-247 2-Lead



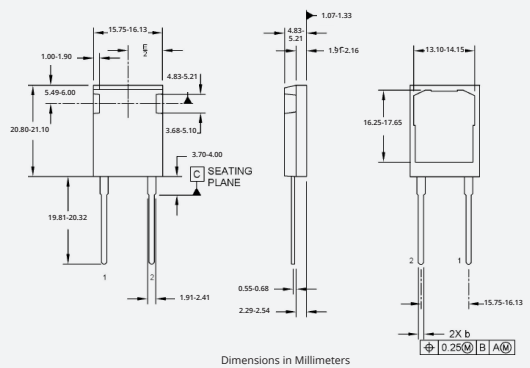
TO-247-3-Lead



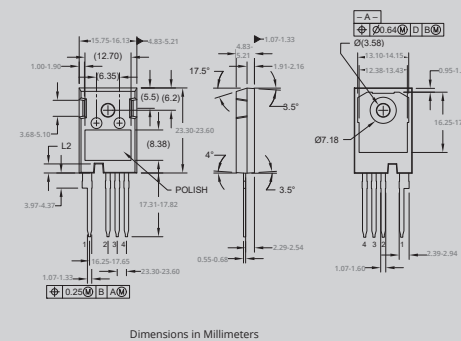
TO-247-4-Lead



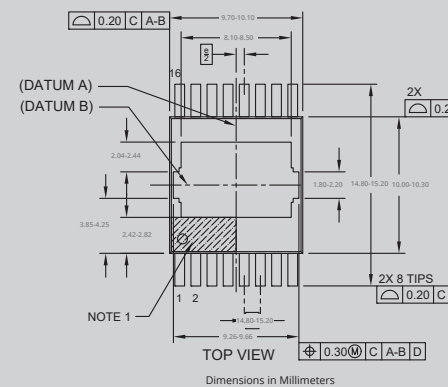
T-MAX®

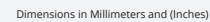
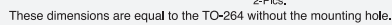
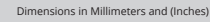
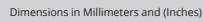
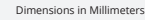
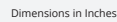


TO-247-4L Notch

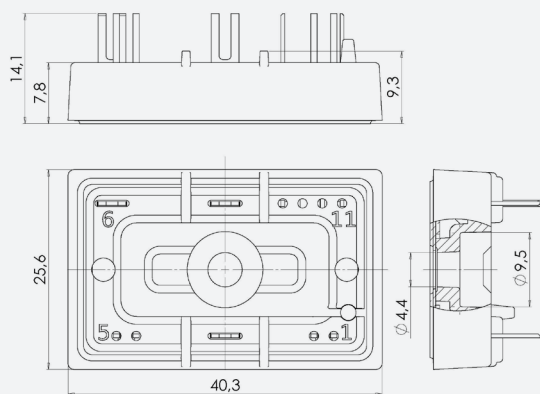


PSMT

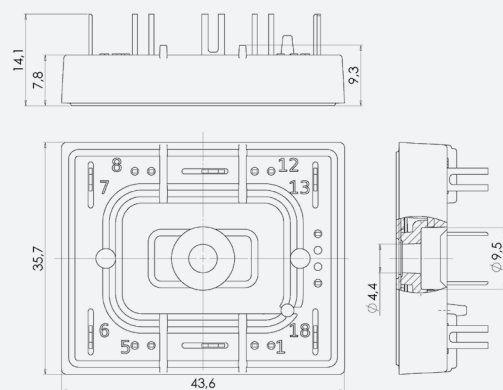




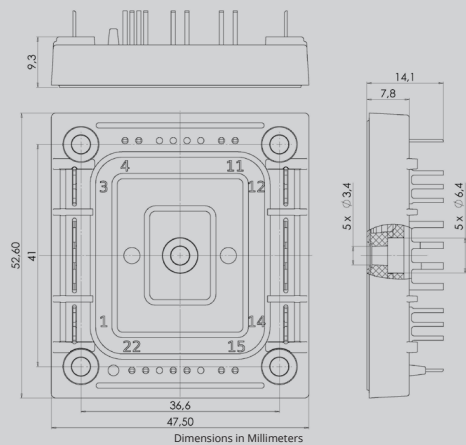
BL1



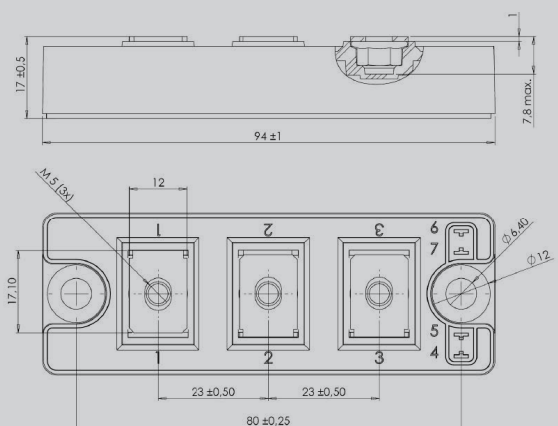
BL2



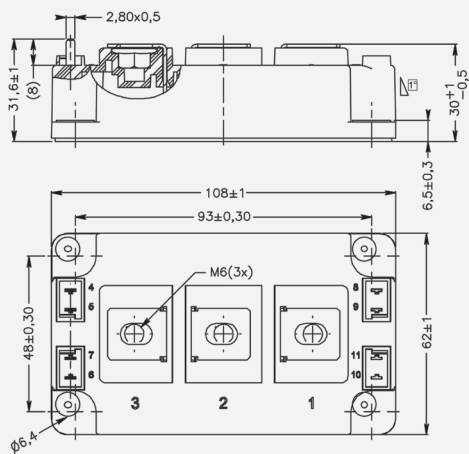
BL3



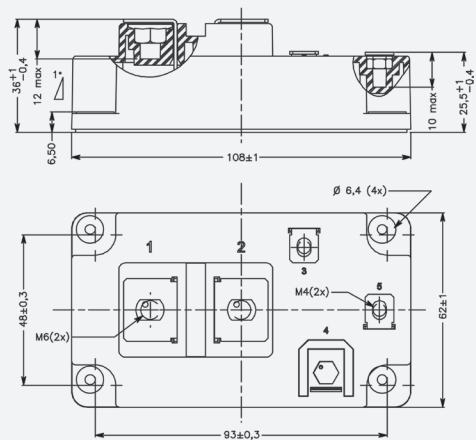
D1P



D3

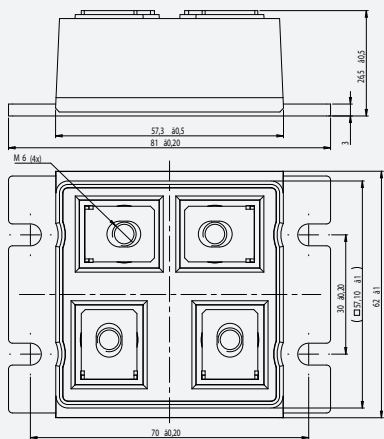


D4

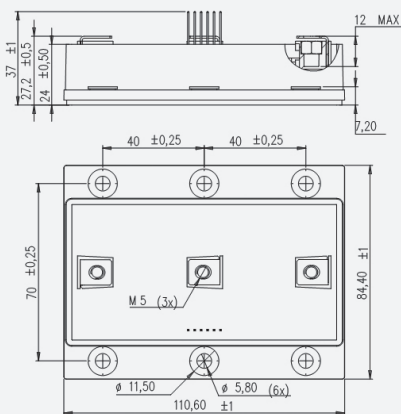


Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters unless otherwise indicated.

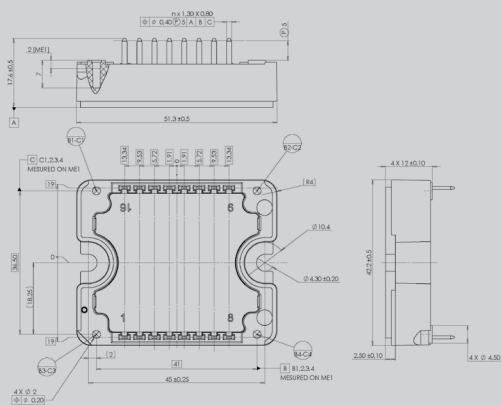
LP4



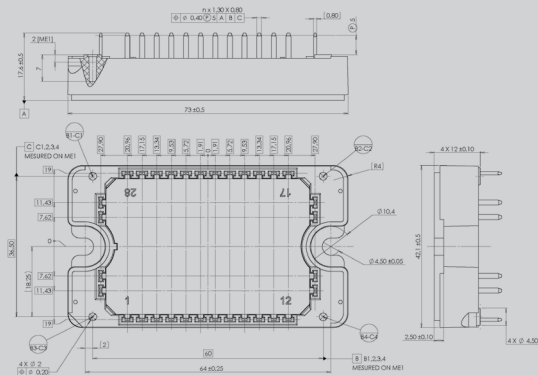
LP8



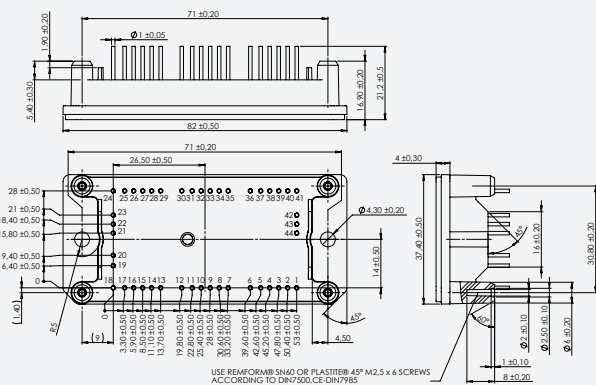
SP1F



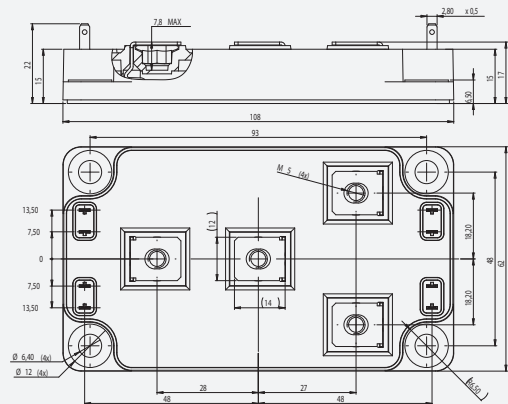
SP3F



SP3X



SP6C Four Outputs, Version 1



Pinout location depends on the module configuration. Please refer to the product datasheet for pin assignments. All dimensions in millimeters.

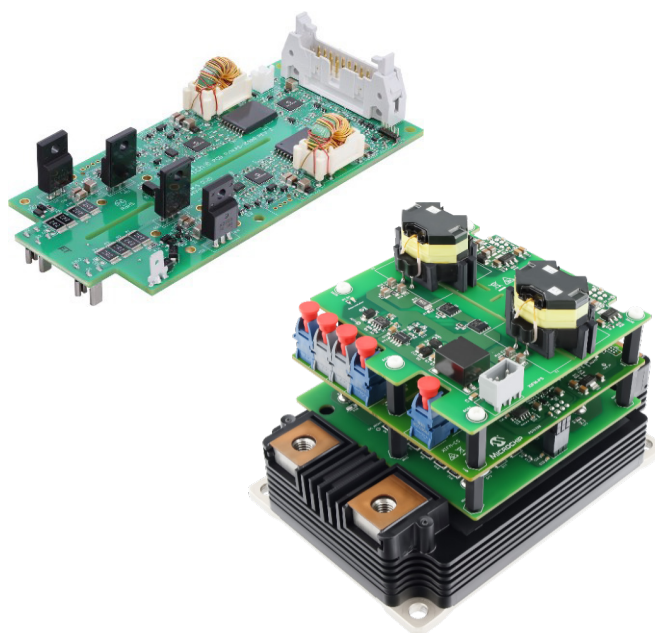
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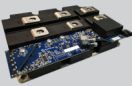
microchip.com/PowerModules

Plug-and-Play mSiC™ Gate Drivers for Power Modules | 1200V – 3.3 kV

Accelerate Time to Market with Plug-and-Play Gate Driver Solutions

Microchip's Portfolio of configurable Plug-and-Play mSiC™ gate drivers complements mSiC modules and it also offers flexibility to adapt to different SiC and IGBT modules. It provides compact solution and features advanced monitoring and protection features like Temperature monitoring, DC link monitoring, UVLO, OVLO, Desat and Negative Temperature coefficient (NTC). It offers the fastest development with increased reliability of the power system.



Plug-and-Play Part Number	Voltage	 D3	 SP6C	HV LinPaK / XHP HV100	IHM IGBT Modules
 HPFM	Up to 3.3 kV				✓
 XIFM	3.3kV			✓	
	1700V			✓	
 62EM1-0001	1700V	✓	✓		
	1200V	✓	✓		

Plug and Play Configurable mSiC Gate Drivers

Part Number	Voltage (V)	Driver Type	Programming Tool	Augmented Switching™	Turn On Voltage Range	Turn Off Voltage Range
62EM1-00001	1700	Dual Channel	ASBK-014	Turn Off	Fixed (+20V)	Fixed (-5V)
XIFM	3300	Dual Channel	ASBK-014	Turn On Turn Off	Configurable (+20V)	Configurable (-5V)

High-Voltage Reference Designs

SiC Design Support - Hardware

Hardware Platform	AC-DC	DC-DC	DC-AC	SSCB	Evaluation Board
High-Voltage Auxiliary E-Fuse Reference Design				✓	
3.8 kW/7.6 kW Totem Pole Demonstration Application	✓		✓		
30 kW 3-Phase Vienna PFC Reference Design	✓				
30 kW Polymorphic DC-DC Converter Reference Design		✓			
11 kW Dual Active Bridge DC-DC Demonstration Application		✓			
11 kW Totem-Pole Demonstration Application	✓		✓		
250-1000V (63W) Auxiliary Power Supply Reference Design		✓			
150 kVA 3-Phase SiC Power Stack Reference Design	✓	✓	✓		
SP6LIEVB					✓

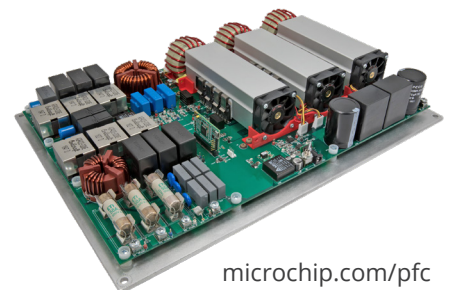
User-Friendly Reference Designs

Microchip and our partner ecosystem provide open-source, user-friendly mSiC MOSFET reference design solutions that enable faster time to market for customers using our mSiC MOSFETs and power modules. You can use isolated dual-gate driver reference designs with our mSiC MOSFETs in a number of topologies.

Vienna 3-Phase Power Factor Correction (PFC) Reference Design

The 3-phase Vienna PFC reference design for Hybrid Electric Vehicle (HEV) and Electric Vehicle (EV) chargers and high-power switch mode power supply applications achieves 98.6% efficiency at 30 kW output power.

- Designed for 30 kW applications
- 1200V mSiC diodes and 700V mSiC MOSFETs with high avalanche/repetitive Unclamped Inductive Switching (UIS)
- 3-phase 380/400V RMS input voltage, 50 Hz or 60 Hz
- 140 kHz switching frequency
- 700V DC output voltage
- PCB layout optimized for safety, current stress, mechanical stress and noise immunity
- dsPIC33CH Digital Signal Controller (DSC) for digital control



microchip.com/pfc

30 kW Polymorphic DC-DC Converter Reference Design

The 30 kW PSFB SiC-based DC-DC power converter is an isolated DC-DC power converter with a PCB layout that is optimized for safety, current stress, mechanical stress and noise immunity. This reference design can be used in Hybrid Electric Vehicle (HEV), off-board charger power supply units and high-power switch mode power supply applications. This reference design also demonstrates the performance of a SiC-based isolated DC-DC converter using MSC025SMA120B4 mSiC MOSFETs and MSC050SDA120BCT mSiC Diodes.

- Designed for 30 kW applications with isolation asymmetrical dual full-bridge topology
- Improved utilization of magnetics for better power density
- Power density: 98.5% with peak efficiency of 7.2 kW/L
- Switching frequency: 140 kHz Pulse-Width Modulation (PWM)
- Input voltage: 650 VDC–750 VDC
- Output voltage: 150 VDC –650 VDC at 60A maximum current



[microchip.com/30kW-PSFB-DCDC](https://www.microchip.com/30kW-PSFB-DCDC)

3.8 kW/7.6 kW Totem Pole Demonstration Application

Featuring dsPIC® Digital Signal Controllers (DSCs) and silicon carbide (SiC) MOSFETs, this demonstration platform is part of an On-Board Charger (OBC) used for charging Electric Vehicles (EVs). This reference design also includes an 8-bit MCU, gate drivers, a buck regulator, a Switch-Mode Power Supply (SMPS) controller, push-pull PWM controller, CAN FD transceiver and LDO. The highly modular and configurable hardware with Plug-in-Modules (PIMs) and flexible software supports different modes of operation, including:

- Enables bidirectional power conversion for an Electric Vehicle (EV) On-Board Charger (OBC)
- Highly modular hardware and firmware that allows operation in different modes
- Supported by code generation tools to accelerate your development
- Forced-air cooled solution with AEC-Q100 qualified components



<https://www.microchip.com/en-us/tools-resources/reference-designs/3-8kw-7-6kw-dspic33c-totem-pole-development-application>

11 kW Dual Active Bridge DC-DC Demonstration Application

Featuring dsPIC Digital Signal Controllers (DSCs) and silicon carbide (SiC) MOSFETs, this demonstration platform is part of an On-Board Charger (OBC) used for charging Electric Vehicles (EVs). This system also includes an 8-bit MCU, gate drivers, a buck regulator, a Switch Mode Power Supply (SMPS) controller, push-pull PWM controller, CAN FD transceiver and LDO. The highly modular and configurable hardware with Plug-in-Modules (PIMs) and flexible software supports different modes of operation.

- 700–900 VDC input and output with bi-directional operation
- Non-linear/adaptive control algorithms for improved performance
- Forced-air cooled solution with AEC-Q100-qualified components

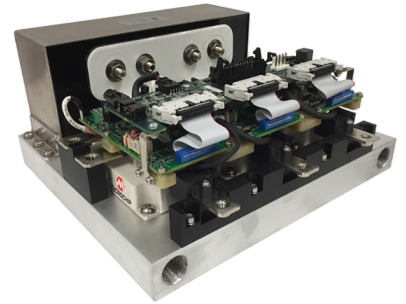


<https://www.microchip.com/en-us/tools-resources/reference-designs/11-kw-dual-active-bridge-dc-dc-demonstration-application>

Mersen 150 kVA 3-Phase SiC Power Stack Evaluation Kit

Designers of EVs, commercial transportation, renewable energy and energy storage systems can benefit from SiC stack solutions that drive performance and cost efficiencies and accelerate time to market.

- 16 kW/L power density
- Up to 130°C Tj
- 98% peak efficiency
- 1200V mSiC MOSFET Modules
- AgileSwitch® gate driver core
- 700 VDC/200 ARMS
- Compact water-cooled design
- Up to 20 kHz switching frequency

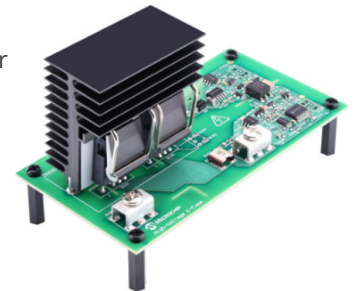


<https://www.microchip.com/en-us/tools-resources/reference-designs/150-kva-3-phase-sic-power-stack-reference-design>

High-Voltage Auxiliary Electronic Fuse (E-Fuse) Demonstrator

You can use high-voltage auxiliary E-Fuse technology for HEV, EV and other non-automotive DC solid-state circuit breaker applications. This technology demonstrator leverages the benefits of our 700V and 1200V mSiC MOSFETs and other technologies to provide a complete solution.

- Configurable current limit profile
- LIN communication interface for configurability and diagnostics
- High-side or low-side drive configuration
- Short-circuit withstand time: 10 μ s
- Rated current: 30A
- Low-voltage operating range: 9V to 16V
- High-voltage operating range: 200V to 900V
- Operating temperature range: -40°C to 85°C
- Automotive hardware design that uses only AEC-qualified components
- Six variants of this high-voltage auxiliary E-Fuse design that support 400V and 800V bus voltages and continuous current ratings of 10A, 20A and 30A
- Up to 20 kHz switching frequency

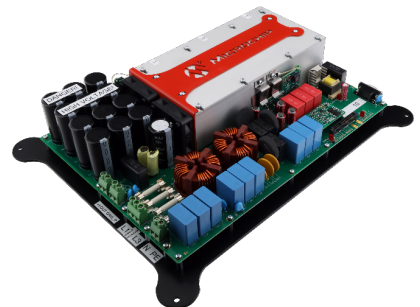


[microchip.com/e-fuse](https://www.microchip.com/e-fuse)

11 kW Totem-Pole Demonstration Application

This demonstration platform features our mSiC MOSFETs, dsPIC® Digital Signal Controllers (DSCs). The demonstration platform also includes our 8-bit microcontroller, gate drivers, buck regulator, Switch Mode Power Supply (SMPS) controller, push-pull PWM controller, CAN FD transceiver and LDO. The highly modular and configurable hardware with Plug-in-Modules (PIMs) and flexible software support different modes of operation, including:

- Three-phase Power Factor Correction (PFC)
- One-phase PFC (single and multiple legs)
- Three-phase inverter
- One-phase inverter



<https://www.microchip.com/en-us/tools-resources/reference-designs/11-kw-totem-pole-demonstration-application>

1000V Auxiliary Power Supply Reference Design

The auxiliary power supply is an essential part of a power converter that converts the electric power from a high-voltage (HV) DC bus to a low-voltage (LV) source for powering control circuits, sensing circuits, cooling fans and other equipment.

- Single switch mode flyback topology
- Wide input voltage of 250V–1000V
- +24V/2A and +15V/1A dual outputs and total output power of 63W
- High power conversion efficiency over wide power range
- Current-mode Pulse-Width Modulation (PWM) controller-based closed-loop control

<https://www.microchip.com/en-us/tools-resources/reference-designs/1000v-auxiliary-power-supply-reference-design>

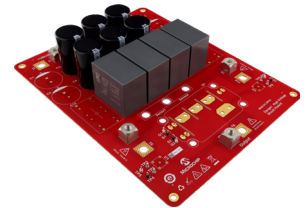


[microchip.com/auxps](https://www.microchip.com/auxps)

SiC Evaluation Boards

SP6LI mSiC™ MOSFET Module Evaluation Board

The SP6LI mSiC MOSFET module evaluation board is a versatile and essential tool for developers looking to leverage the SP6LI SiC module in power electronics. It streamlines the design process, reduces development risks and paves the way for the creation of energy-efficient, high-performance power electronic systems.



This system enables users to:

- Measure switching loss (E_{on} , E_{off} and Q_{rr}) and high-side and low-side overcurrent protection (DSAT)
- Optimize gate driver switching behavior
- Evaluate up to 1200V SP6LI mSiC MOSFET modules
- Perform extensive thermal testing to assess performance in practical situations

<https://www.microchip.com/en-us/development-tool/MSCDR-SP6LIEVB-001>

Simulation and Models

Microchip offers a variety of simulation tools that help designers lower design complexities and shorten design cycle times. Both device and system level tools are available for use in device evaluation, system development and scaling of existing system level models.

Our models and simulation tools are built to save time and cost for development with SiC-based power systems. Our models help you achieve real-world accuracy to get your design to market faster. Our MPLAB SiC Power Simulator helps you evaluate mSiC™ products risk-free in multiple topologies using converter-level simulation models.



MPLAB® SiC Power Simulator

The MPLAB SiC Power Simulator calculates power losses and estimates junction temperature for SiC devices using lab testing data for common power converter topologies in DC-AC, AC-DC and DC-DC applications.

Relevant links: microchip.com/sicpowersim



MPLAB® Mindi™ Analog Simulator

Free SPICE circuit simulation tool that uses a SIMetrix/SIMPLIS simulation environment.

What's available: Free MPLAB Mindi Analog Simulator download. SiC Models are available for the 700V, 1200V and 1700V mSiC MOSFETs and Schottky Barrier Diodes

Relevant links: Simulation tool download at microchip.com/mplab/mplab-mindi and SiC models at microchip.com

SPICE Models

SPICE is a widely used circuit simulation that provides the ability to evaluate a device within a circuit design. SPICE models support this simulation work by designers.

What's available: Microchip provides SPICE models for all of its newest mSiC Diodes and mSiC MOSFETs in 700V, 1200V, and 1700V blocking voltages.

<https://www.microchip.com/en-us/software-library/sic-products-spice-files>

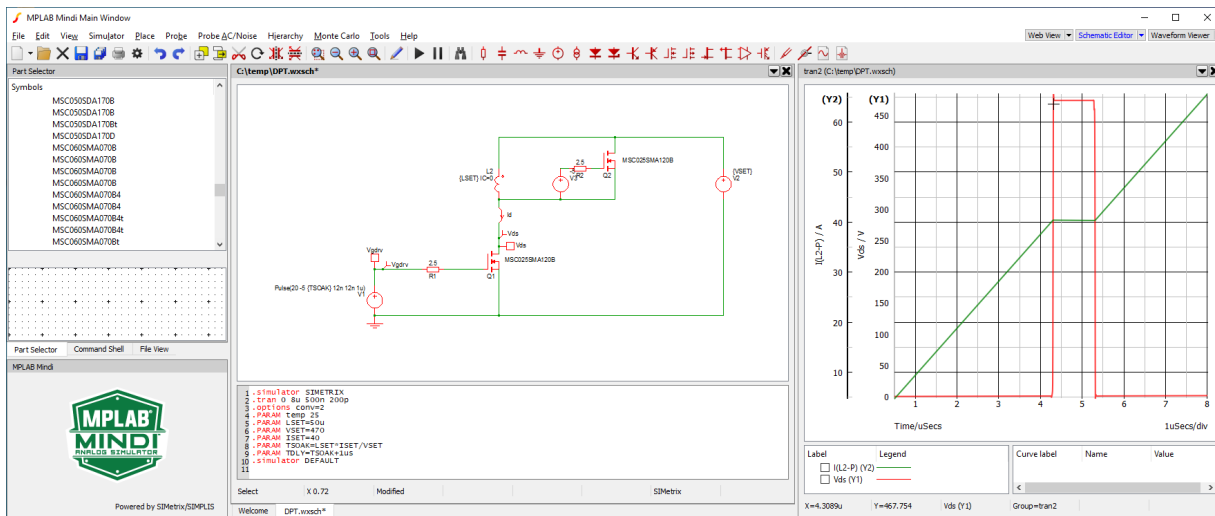
PLECS Models

PLECS models provide device switching and conduction losses as well as thermal characterization for use in PLECS multi-domain simulations.

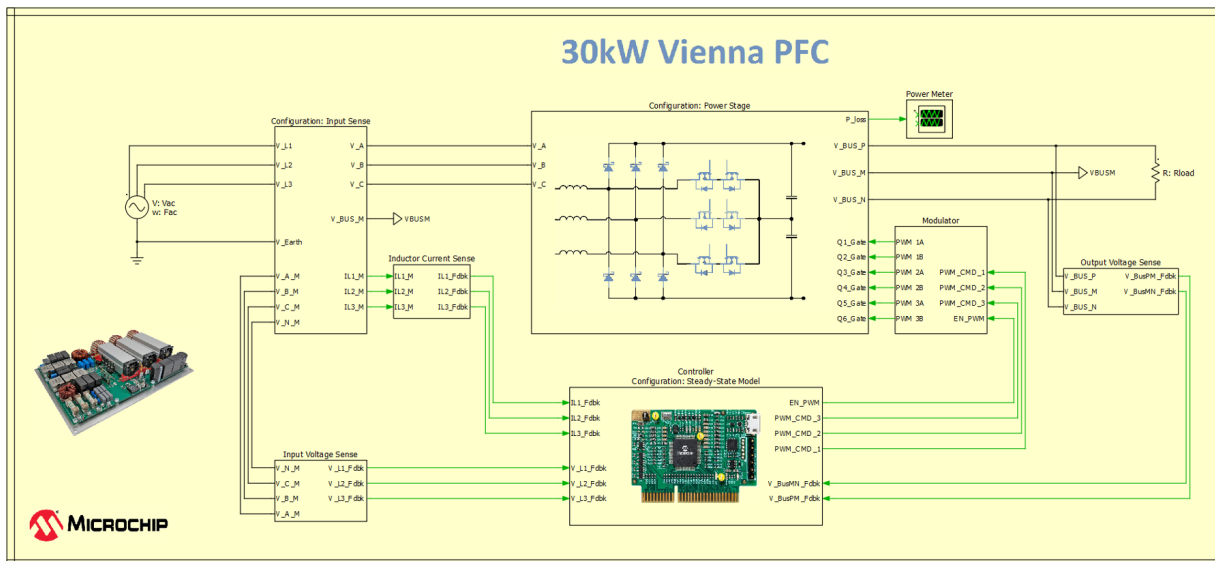
What's available: Vienna 3-Phase Power Factor Correction (PFC) Reference Design PLECS simulation model

Relevant links: [microchip.com/plecs](https://www.microchip.com/plecs)

MPLAB® Mindi™ SPICE Circuit Simulation Model



PLECS Simulation Model for 30 kW Vienna PFC





Support

Microchip is committed to supporting its customers in developing products faster and more efficiently. We maintain a worldwide network of field applications engineers and technical support ready to provide product and system assistance. For more information, please visit www.microchip.com:

Technical Support: www.microchip.com/support

Evaluation samples of any Microchip device:
www.microchip.com/sample

Knowledge base and peer help:
www.microchip.com/forums

Sales and Global Distribution: www.microchip.com/sales



Training

If additional training interests you, Microchip offers several resources including in-depth technical training and reference material, self-paced tutorials and significant online resources.

Overview of Technical Training Resources:
www.microchip.com/training

Microchip University:
www.microchip.com/mu

Developer Help Website:
www.microchip.com/developerhelp

Technical Training Centers:
www.microchip.com/seminars

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